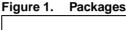


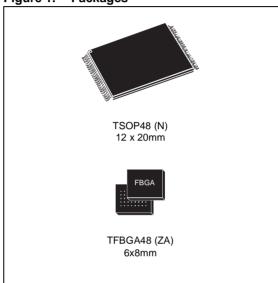
M29W640FT M29W640FB

64 Mbit (8Mb x8 or 4Mb x16, Page, Boot Block) 3V Supply Flash Memory

Features summary

- Supply Voltage
 - V_{CC} = 2.7V to 3.6V for Program, Erase, Read
 - V_{PP} =12 V for Fast Program (optional)
- Asynchronous Random/Page Read
 - Page Width: 4 Words
 - Page Access: 25ns
 - Random Access: 60ns, 70ns
- Programming Time
 - 10 µs per Byte/Word typical
 - 4 Words/8 Bytes Program
- 135 memory blocks
 - 1 Boot Block and 7 Parameter Blocks, 8 KBytes each (Top or Bottom Location)
 - 127 Main Blocks, 64 KBytes each
- Program/Erase Controller
 - Embedded Byte/Word Program algorithms
- Program/Erase Suspend and Resume
 - Read from any Block during Program Suspend
 - Read and Program another Block during **Erase Suspend**
- Unlock Bypass Program command
 - Faster Production/Batch Programming
- V_{PP}/WP pin for Fast Program and Write Protect
- Temporary Block Unprotection mode
- Common Flash Interface
 - 64-bit Security Code
- Extended Memory Block
 - Extra block used as security block or to store additional information
- Low power consumption
 - Standby and Automatic Standby
- 100,000 Program/Erase cycles per block





- Electronic Signature
 - Manufacturer Code: 0020h

Table 1. **Device Codes**

Root Part Number	Device Code
M29W640FT	22EDh
M29W640FB	22FDh

■ ECOPACK[®] packages

Contents

1	Sum	mary description													
2	Sign	Signal descriptions 1													
	2.1	Address Inputs (A0-A21)													
	2.2	Data Inputs/Outputs (DQ0-DQ7)													
	2.3	Data Inputs/Outputs (DQ8-DQ14)													
	2.4	Data Input/Output or Address Input (DQ15A-1)													
	2.5	Chip Enable (E)													
	2.6	Output Enable (G)													
	2.7	Write Enable (W)													
	2.8	V _{PP} /Write Protect (V _{PP/} WP)													
	2.9	Reset/Block Temporary Unprotect (RP)													
	2.10	Ready/Busy Output (RB)													
	2.11	Byte/Word Organization Select (BYTE)													
	2.12	V _{CC} Supply Voltage (2.7V to 3.6V)													
	2.13	V _{SS} Ground													
3	Bus	operations15													
	3.1	Bus Read													
	3.2	Bus Write													
	3.3	Output Disable													
	3.4	Standby													
	3.5	Automatic Standby 16													
	3.6	Special Bus Operations													
		3.6.1 Electronic Signature													
		3.6.2 Block Protect and Chip Unprotect													
4	Com	mand Interface													
	4.1	Standard commands													
		4.1.1 Read/Reset command													
		4.1.2 Auto Select command													
		4.1.3 Read CFI Query command													

M29W640FT, M29W640FB

		4.1.4	Chip Erase command	20
		4.1.5	Block Erase command	20
		4.1.6	Erase Suspend command	21
		4.1.7	Erase Resume command	21
		4.1.8	Program Suspend command	21
		4.1.9	Program Resume command	22
		4.1.10	Program command	22
	4.2	Fast P	rogram commands	23
		4.2.1	Double Byte Program command	23
		4.2.2	Quadruple Byte Program command	23
		4.2.3	Octuple Byte Program command	24
		4.2.4	Double Word Program command	24
		4.2.5	Quadruple Word Program command	25
		4.2.6	Unlock Bypass command	25
		4.2.7	Unlock Bypass Program command	25
		4.2.8	Unlock Bypass Reset command	25
	4.3	Block	Protection commands	26
		4.3.1	Enter Extended Block command	26
		4.3.2	Exit Extended Block command	26
		4.3.3	Block Protect and Chip Unprotect commands	27
5	Statu	s Regi	ster	30
	5.1	Data F	Polling Bit (DQ7)	30
	5.2	Toggle	Bit (DQ6)	30
	5.3		Bit (DQ5)	
	5.4		Timer Bit (DQ3)	
	-		· ,	
	5.5	Aiterna	ative Toggle Bit (DQ2)	31
6	Maxir	num ra	ating	34
7	DC a	nd AC	parameters	35
8	Packa	age me	echanical	44
9	Part N	Numbe	ring	46
Annor	div A	Block	addresses	47
whhei	IUIX A	DIOCK	. auure3363	41
577				3/72

M29W640FT, M29W640FB

Appendix B	Common Flash Interface (CFI)	57
Appendix C	Extended Memory Block	33
C.1	Factory Locked Extended Block	3
C.2	Customer Lockable Extended Block	33
Appendix D	Block Protection	35
D.1	Programmer Technique	35
D.2	In-System Technique	35
10 Revis	sion History	71

List of tables

Table 1.	Device Codes
Table 1.	Signal Names
Table 2.	Hardware Protection
Table 3.	Bus Operations, BYTE = V _{IL}
Table 4.	Bus Operations, BYTE = V _{IH}
Table 5.	Commands, 16-bit mode, BYTE = V _{IH}
Table 6.	Commands, 8-bit mode, BYTE = V _{IL}
Table 7.	Program, Erase Times and Program, Erase Endurance Cycles
Table 8.	Status Register Bits
Table 9.	Absolute Maximum Ratings
Table 10.	Operating and AC Measurement Conditions
Table 11.	Device Capacitance
Table 12.	DC Characteristics
Table 13.	Read AC Characteristics
Table 14.	Write AC Characteristics, Write Enable Controlled40
Table 15.	Write AC Characteristics, Chip Enable Controlled
Table 16.	Reset/Block Temporary Unprotect AC Characteristics
Table 17.	TSOP48 – 48 lead Plastic Thin Small Outline, 12 x 20mm, Package Mechanical Data 44
Table 18.	TFBGA48 6x8mm - 6x8 active ball array, 0.8mm pitch, Package Mechanical Data 45
Table 19.	Ordering Information Scheme46
Table 20.	Top Boot Block Addresses, M29W640FT47
Table 21.	Bottom Boot Block Addresses, M29W640FB52
Table 22.	Query Structure Overview
Table 23.	CFI Query Identification String
Table 24.	CFI Query System Interface Information
Table 25.	Device Geometry Definition
Table 26.	Primary Algorithm-Specific Extended Query Table
Table 27.	Security Code Area62
Table 28.	Extended Block Address and Data
Table 29.	Programmer Technique Bus Operations, BYTE = V _{IH} or V _{IL} 66
Table 30.	Document Revision History

List of figures

Figure 1.	Packages	1
Figure 1.	Logic Diagram	
Figure 2.	TSOP Connections	
Figure 3.	TFBGA48 Connections (Top view through package)	
Figure 4.	Data Polling Flowchart	
Figure 5.	Data Toggle Flowchart	
Figure 6.	AC Measurement I/O Waveform	
Figure 7.	AC Measurement Load Circuit	
Figure 8.	Read Mode AC Waveforms	
Figure 9.	Page Read AC Waveforms	37
Figure 10.	Write AC Waveforms, Write Enable Controlled	
Figure 11.	Write AC Waveforms, Chip Enable Controlled	
Figure 12.	Reset/Block Temporary Unprotect AC Waveforms.	
Figure 13.	Accelerated Program Timing Waveforms	
Figure 14.	TSOP48 – 48 lead Plastic Thin Small Outline, 12 x 20mm, Package Outline	
Figure 15.	TFBGA48 6x8mm - 6x8 active ball array, 0.8mm pitch, Package Outline	
Figure 16.	Programmer Equipment Group Protect Flowchart	
Figure 17.	Programmer Equipment Chip Unprotect Flowchart	
Figure 18.	In-System Equipment Group Protect Flowchart	
Figure 19.	In-System Equipment Chip Unprotect Flowchart	



1 Summary description

The M29W640F is a 64 Mbit (8Mb x8 or 4Mb x16) non-volatile memory that can be read, erased and reprogrammed. These operations can be performed using a single low voltage (2.7 to 3.6V) supply. On power-up the memory defaults to its Read mode.

The memory is divided into blocks that can be erased independently so it is possible to preserve valid data while old data is erased. Blocks can be protected in units of 256 KByte (generally groups of four 64 KByte blocks), to prevent accidental Program or Erase commands from modifying the memory. Program and Erase commands are written to the Command Interface of the memory. An on-chip Program/Erase Controller simplifies the process of programming or erasing the memory by taking care of all of the special operations that are required to update the memory contents. The end of a program or erase operation can be detected and any error conditions identified. The command set required to control the memory is consistent with JEDEC standards.

The device features an asymmetrical blocked architecture. The device has an array of 135 blocks:

- 8 Parameters Blocks of 8 KBytes each (or 4 KWords each)
- 127 Main Blocks of 64 KBytes each (or 32 KWords each)

M29W640FT has the Parameter Blocks at the top of the memory address space while the M29W640FB locates the Parameter Blocks starting from the bottom.

The M29W640F has an extra block, the Extended Block, of 128 Words in x16 mode or of 256 Byte in x8 mode that can be accessed using a dedicated command. The Extended Block can be protected and so is useful for storing security information. However the protection is not reversible, once protected the protection cannot be undone.

Chip Enable, Output Enable and Write Enable signals control the bus operation of the memory. They allow simple connection to most microprocessors, often without additional logic.

The V_{PP}/\overline{WP} signal is used to enable faster programming of the device, enabling multiple word/byte programming. If this signal is held at V_{SS} , the boot block, and its adjacent parameter block, are protected from program and erase operations.

The device supports Asynchronous Random Read and Page Read from all blocks of the memory array.

The memories are offered in TSOP48 (12x 20mm) and TFBGA48 (6x8mm, 0.8mm pitch) packages.

In order to meet environmental requirements, ST offers the M29W640FT and the M29W640FB in ECOPACK® packages. ECOPACK packages are Lead-free. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

The memory is delivered with all the bits erased (set to 1).

Figure 1. Logic Diagram

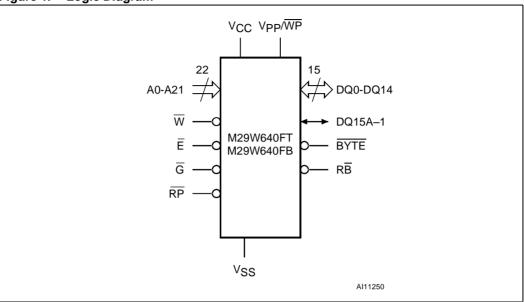
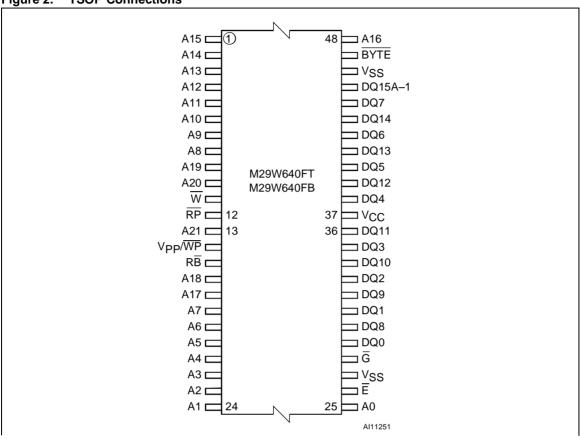
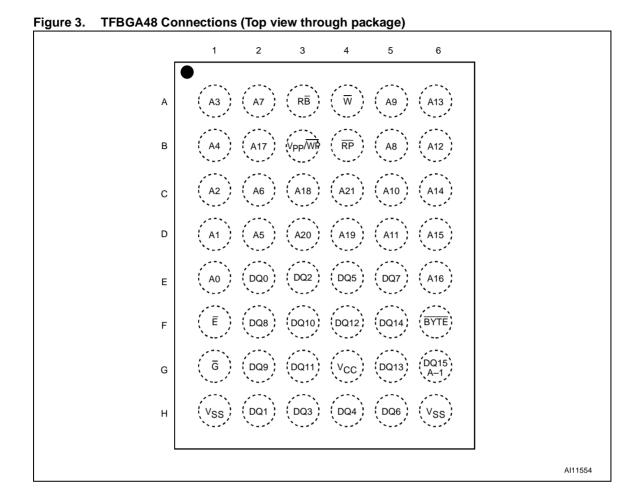


Table 1. Signal Names

Table I. Signal Na	illes
A0-A21	Address Inputs
DQ0-DQ7	Data Inputs/Outputs
DQ8-DQ14	Data Inputs/Outputs
DQ15A-1 (or DQ15)	Data Input/Output or Address Input (or Data Input/Output)
Ē	Chip Enable
G	Output Enable
W	Write Enable
RP	Reset/Block Temporary Unprotect
RB	Ready/Busy Output
BYTE	Byte/Word Organization Select
V _{CC}	Supply Voltage
V _{PP} /WP	Supply Voltage for Fast Program (optional) or Write Protect
V _{SS}	Ground
NC	Not Connected Internally

Figure 2. TSOP Connections





2 Signal descriptions

See Figure 1: Logic Diagram, and Table 1: Signal Names, for a brief overview of the signals connected to this device.

2.1 Address Inputs (A0-A21)

The Address Inputs select the cells in the memory array to access during Bus Read operations. During Bus Write operations they control the commands sent to the Command Interface of the Program/Erase Controller.

2.2 Data Inputs/Outputs (DQ0-DQ7)

The Data I/O outputs the data stored at the selected address during a Bus Read operation. During Bus Write operations they represent the commands sent to the Command Interface of the Program/Erase Controller.

2.3 Data Inputs/Outputs (DQ8-DQ14)

The Data I/O outputs the data stored at the selected address during a Bus Read operation when $\overline{\text{BYTE}}$ is High, V_{IH} . When $\overline{\text{BYTE}}$ is Low, V_{IL} , these pins are not used and are high impedance. During Bus Write operations the Command Register does not use these bits. When reading the Status Register these bits should be ignored.

2.4 Data Input/Output or Address Input (DQ15A-1)

When \overline{BYTE} is High, V_{IH} , this pin behaves as a Data Input/Output pin (as DQ8-DQ14). When \overline{BYTE} is Low, V_{IL} , this pin behaves as an address pin; DQ15A–1 Low will select the LSB of the addressed Word, DQ15A–1 High will select the MSB. Throughout the text consider references to the Data Input/Output to include this pin when \overline{BYTE} is High and references to the Address Inputs to include this pin when \overline{BYTE} is Low except when stated explicitly otherwise.

2.5 Chip Enable (\overline{E})

The Chip Enable, \overline{E} , activates the memory, allowing Bus Read and Bus Write operations to be performed. When Chip Enable is High, V_{IH} , all other pins are ignored.

2.6 Output Enable (G)

The Output Enable, \overline{G} , controls the Bus Read operation of the memory.

2.7 Write Enable (\overline{W})

The Write Enable, W, controls the Bus Write operation of the memory's Command Interface.

2.8 V_{PP}/Write Protect (V_{PP}/WP)

The V_{PP} /Write Protect pin provides two functions. The V_{PP} function allows the memory to use an external high voltage power supply to reduce the time required for Unlock Bypass Program operations. The Write Protect function provides a hardware method of protecting the two outermost boot blocks. The V_{PP} /Write Protect pin must not be left floating or unconnected.

When V_{PP} /Write Protect is Low, V_{IL} , the memory protects the two outermost boot blocks; Program and Erase operations in this block are ignored while V_{PP} /Write Protect is Low, even when \overline{RP} is at V_{ID} .

When V_{PP}/W rite Protect is High, V_{IH} , the memory reverts to the previous protection status of the two outermost boot blocks. Program and Erase operations can now modify the data in the two outermost boot blocks unless the block is protected using Block Protection.

Applying V_{PPH} to the V_{PP}/WP pin will temporarily unprotect any block previously protected (including the two outermost parameter blocks) using a High Voltage Block Protection technique (In-System or Programmer technique). See *Table 2: Hardware Protection* for details.

When V_{PP} /Write Protect is raised to V_{PP} the memory automatically enters the Unlock Bypass mode. When V_{PP} /Write Protect returns to V_{IH} or V_{IL} normal operation resumes. During Unlock Bypass Program operations the memory draws I_{PP} from the pin to supply the programming circuits. See the description of the Unlock Bypass command in the Command Interface section. The transitions from V_{IH} to V_{PP} and from V_{PP} to V_{IH} must be slower than t_{VHVPP} see *Figure 13: Accelerated Program Timing Waveforms*.

Never raise V_{PP} /Write Protect to V_{PP} from any mode except Read mode, otherwise the memory may be left in an indeterminate state.

A $0.1\mu F$ capacitor should be connected between the V_{PP}/W rite Protect pin and the V_{SS} Ground pin to decouple the current surges from the power supply. The PCB track widths must be sufficient to carry the currents required during Unlock Bypass Program, I_{PP}

Table 2. Hardware Protection

V _{PP} /WP	RP	Function
V _{IL}	V _{IH}	2 outermost parameter blocks protected from Program/Erase operations
V IL	V _{ID}	All blocks temporarily unprotected except the 2 outermost blocks
V _{IH} or V _{ID}	V _{ID}	All blocks temporarily unprotected
V _{PPH}	V _{IH} or V _{ID}	All blocks temporarily unprotected

2.9 Reset/Block Temporary Unprotect (RP)

The Reset/Block Temporary Unprotect pin can be used to apply a Hardware Reset to the memory or to temporarily unprotect all Blocks that have been protected.

Note that if V_{PP}/\overline{WP} is at V_{IL} , then the two outermost boot blocks will remain protected even if RP is at V_{ID} .

A Hardware Reset is achieved by holding Reset/Block Temporary Unprotect Low, V_{IL}, for at least t_{PLPX}. After Reset/Block Temporary Unprotect goes High, V_{IH}, the memory will be ready for Bus Read and Bus Write operations after t_{PHEL} or t_{RHEL}, whichever occurs last. See the Ready/Busy Output section, *Table 16: Reset/Block Temporary Unprotect AC Characteristics* and *Figure 12: Reset/Block Temporary Unprotect AC Waveforms*, for more details.

Holding \overline{RP} at V_{ID} will temporarily unprotect the protected Blocks in the memory. Program and Erase operations on all blocks will be possible. The transition from V_{IH} to V_{ID} must be slower than t_{PHPHH} .

2.10 Ready/Busy Output (RB)

The Ready/Busy pin is an open-drain output that can be used to identify when the device is performing a Program or Erase operation. During Program or Erase operations Ready/Busy is Low, V_{OL}. Ready/Busy is high-impedance during Read mode, Auto Select mode and Erase Suspend mode.

After a Hardware Reset, Bus Read and Bus Write operations cannot begin until Ready/Busy becomes high-impedance. See *Table 16: Reset/Block Temporary Unprotect AC Characteristics* and *Figure 12: Reset/Block Temporary Unprotect AC Waveforms*, for more details.

The use of an open-drain output allows the Ready/Busy pins from several memories to be connected to a single pull-up resistor. A Low will then indicate that one, or more, of the memories is busy.

2.11 Byte/Word Organization Select (BYTE)

The Byte/Word Organization Select pin is used to switch between the x8 and x16 Bus modes of the memory. When Byte/Word Organization Select is Low, V_{IL} , the memory is in x8 mode, when it is High, V_{IH} , the memory is in x16 mode.

2.12 V_{CC} Supply Voltage (2.7V to 3.6V)

V_{CC} provides the power supply for all operations (Read, Program and Erase).

The Command Interface is disabled when the V_{CC} Supply Voltage is less than the Lockout Voltage, V_{LKO} . This prevents Bus Write operations from accidentally damaging the data during power up, power down and power surges. If the Program/Erase Controller is programming or erasing during this time then the operation aborts and the memory contents being altered will be invalid.

A $0.1\mu F$ capacitor should be connected between the V_{CC} Supply Voltage pin and the V_{SS} Ground pin to decouple the current surges from the power supply. The PCB track widths must be sufficient to carry the currents required during Program and Erase operations, I_{CC3} .

2.13 V_{SS} Ground

 $\rm V_{SS}$ is the reference for all voltage measurements. The device features two $\rm V_{SS}$ pins which must be both connected to the system ground.

3 Bus operations

There are five standard bus operations that control the device. These are Bus Read, Bus Write, Output Disable, Standby and Automatic Standby. See *Table 3: Bus Operations, BYTE = VIL* and *Table 4: Bus Operations, BYTE = VIH*, for a summary. Typically glitches of less than 5ns on Chip Enable or Write Enable are ignored by the memory and do not affect bus operations.

3.1 Bus Read

Bus Read operations read from the memory cells, or specific registers in the Command Interface. A valid Bus Read operation involves setting the desired address on the Address Inputs, applying a Low signal, V_{IL} , to Chip Enable and Output Enable and keeping Write Enable High, V_{IH} . The Data Inputs/Outputs will output the value, see *Figure 8: Read Mode AC Waveforms*, and *Table 13: Read AC Characteristics*, for details of when the output becomes valid.

3.2 Bus Write

Bus Write operations write to the Command Interface. To speed up the read operation the memory array can be read in Page mode where data is internally read and stored in a page buffer. The Page has a size of 4 Words and is addressed by the address inputs A0-A1.

A valid Bus Write operation begins by setting the desired address on the Address Inputs. The Address Inputs are latched by the Command Interface on the falling edge of Chip Enable or Write Enable, whichever occurs last. The Data Inputs/Outputs are latched by the Command Interface on the rising edge of Chip Enable or Write Enable, whichever occurs first. Output Enable must remain High, V_{IH}, during the whole Bus Write operation. See *Figure 10: Write AC Waveforms, Write Enable Controlled, Figure 11: Write AC Waveforms, Chip Enable Controlled,* and *Table 14: Write AC Characteristics, Write Enable Controlled*, for details of the timing requirements.

3.3 Output Disable

The Data Inputs/Outputs are in the high impedance state when Output Enable is High, VIH.

3.4 Standby

When Chip Enable is High, V_{IH} , the memory enters Standby mode and the Data Inputs/Outputs pins are placed in the high-impedance state. To reduce the Supply Current to the Standby Supply Current, I_{CC2} , Chip Enable should be held within $V_{CC} \pm 0.2V$. For the Standby current level see *Table 12: DC Characteristics*.

During program or erase operations the memory will continue to use the Program/Erase Supply Current, I_{CC3}, for Program or Erase operations until the operation completes.

3.5 Automatic Standby

If CMOS levels ($V_{CC}\pm0.2V$) are used to drive the bus and the bus is inactive for 300ns or more the memory enters Automatic Standby where the internal Supply Current is reduced to the Standby Supply Current, I_{CC2} . The Data Inputs/Outputs will still output data if a Bus Read operation is in progress.

3.6 Special Bus Operations

Additional bus operations can be performed to read the Electronic Signature and also to apply and remove Block Protection. These bus operations are intended for use by programming equipment and are not usually used in applications. They require V_{ID} to be applied to some pins.

3.6.1 Electronic Signature

The memory has two codes, the manufacturer code and the device code, that can be read to identify the memory. These codes can be read by applying the signals listed in *Table 3: Bus Operations*, *BYTE* = *VIL* and *Table 4: Bus Operations*, *BYTE* = *VIH*.

3.6.2 Block Protect and Chip Unprotect

Groups of blocks can be protected against accidental Program or Erase. The Protection Groups are shown in *Appendix A: Block addresses Table 20* and *Table 21*. The whole chip can be unprotected to allow the data inside the blocks to be changed.

The V_{PP}/W rite Protect pin can be used to protect the two outermost boot blocks. When V_{PP}/W rite Protect is at V_{IL} the two outermost boot blocks are protected and remain protected regardless of the Block Protection Status or the Reset/Block Temporary Unprotect pin status.

Block Protect and Chip Unprotect operations are described in Appendix D: Block Protection.

Table 3. Bus Operations, $\overline{\text{BYTE}} = V_{\text{IL}}$

Operation	Ē	G	w	Address Inputs	Data	Inputs/Outputs
Operation		G	**	DQ15A-1, A0-A21	DQ14-DQ8	DQ7-DQ0
Bus Read	V_{IL}	V_{IL}	V _{IH}	Cell Address	Hi-Z	Data Output
Bus Write	V _{IL}	V _{IH}	V _{IL}	Command Address	Hi-Z	Data Input
Output Disable	Х	V _{IH}	V _{IH}	Х	Hi-Z	Hi-Z
Standby	V_{IH}	Х	Х	Х	Hi-Z	Hi-Z
Read Manufacturer Code	V _{IL}	V _{IL}	V _{IH}	$A0-A3 = V_{IL}, A6 = V_{IL},$ $A9 = V_{ID}, Others V_{IL} or V_{IH}$	Hi-Z	20h
Read Device Code	and Device Code V _{IL}		V _{IH}	$A0 = V_{IH}, A1-A3 = V_{IL},$ $A6 = V_{IL}, A9 = V_{ID},$ $Others V_{IL} or V_{IH}$	Hi-Z	EDh (M29W640FT) FDh (M29W640FB)
Read Extended Memory Block Verify Code	V _{IL}	V _{IL}	V _{IH}	$A0 -A1 = V_{IH}, A2-A3 = V_{IL},$ $A6 = V_{IL}, A9 = V_{ID},$ $Others V_{IL} or V_{IH}$	Hi-Z	80h (factory locked) 00h (Customer Lockable)
Read Block Protection Status	V _{IL}	V _{IL}	V _{IH}	A0,A2,A3, A6= V_{IL} , A1= V_{IH} , A9 = V_{ID} , A12-A21 = Block Address, Others V_{IL} or V_{IH}	Hi-Z	01h (protected) 00h (unprotected)

^{1.} $X = V_{IL}$ or V_{IH} .

Table 4. Bus Operations, $\overline{\text{BYTE}} = V_{\text{IH}}$

Operation	Ē	G	w	Address Inputs A0-A21	Data Inputs/Outputs DQ15A-1, DQ14-DQ0
Bus Read	V _{IL}	V _{IL}	V _{IH}	Cell Address	Data Output
Bus Write	V_{IL}	V _{IH}	V_{IL}	Command Address	Data Input
Output Disable	Х	V _{IH}	V _{IH}	Х	Hi-Z
Standby	V_{IH}	Х	Х	Х	Hi-Z
Read Manufacturer Code	V_{IL}	V _{IL}	V _{IH}	$A0-A3 = V_{IL}, A6 = V_{IL},$ $A9 = V_{ID}, Others V_{IL} or V_{IH}$	0020h
Read Device Code	V _{IL}	V _{IL}	V _{IH}	$A0 = V_{IH}$, $A1-A3 = V_{IL}$, $A6 = V_{IL}$, $A9 = V_{ID}$, Others V_{IL} or V_{IH}	22EDh (M29W640FT) 22FDh (M29W640FB)
Read Extended Memory Block Verify Code	V _{IL}	V _{IL}	V _{IH}	$A0 -A1 = V_{IH}, A2-A3 = V_{IL},$ $A6 = V_{IL}, A9 = V_{ID},$ $Others V_{IL} or V_{IH}$	80h (factory locked) 00h (Customer Lockable)
Read Block Protection Status	V _{IL}	V _{IL}	V _{IH}	$\begin{array}{l} \text{A0,A2,A3, A6= V}_{\text{IL}},\\ \text{A1 = V}_{\text{IH}}, \text{ A9 = V}_{\text{ID}},\\ \text{A12-A21 = Block Address,}\\ \text{Others V}_{\text{IL}} \text{ or V}_{\text{IH}} \end{array}$	0001h (protected) 0000h (unprotected)

^{1.} $X = V_{IL}$ or V_{IH} .

4 Command Interface

All Bus Write operations to the memory are interpreted by the Command Interface. Commands consist of one or more sequential Bus Write operations. Failure to observe a valid sequence of Bus Write operations will result in the memory returning to Read mode. The long command sequences are imposed to maximize data security.

The address used for the commands changes depending on whether the memory is in 16-bit or 8-bit mode. See either *Table 5*, or *Table 6*, depending on the configuration that is being used, for a summary of the commands.

4.1 Standard commands

4.1.1 Read/Reset command

The Read/Reset command returns the memory to its Read mode. It also resets the errors in the Status Register. Either one or three Bus Write operations can be used to issue the Read/Reset command.

The Read/Reset command can be issued, between Bus Write cycles before the start of a program or erase operation, to return the device to read mode. If the Read/Reset command is issued during the timeout of a Block Erase operation then the memory will take up to 10µs to abort. During the abort period no valid data can be read from the memory. The Read/Reset command will not abort an Erase operation when issued while in Erase Suspend.

4.1.2 Auto Select command

The Auto Select command is used to read the Manufacturer Code, the Device Code, the Block Protection Status and the Extended Memory Block Verify Code. Three consecutive Bus Write operations are required to issue the Auto Select command. Once the Auto Select command is issued the memory remains in Auto Select mode until a Read/Reset command is issued. Read CFI Query and Read/Reset commands are accepted in Auto Select mode, all other commands are ignored.

In Auto Select mode, the Manufacturer Code and the Device Code can be read by using a Bus Read operation with addresses and control signals set as shown in *Table 3: Bus Operations*, BYTE = VIL and *Table 4: Bus Operations*, BYTE = VIH, except for A9 that is 'Don't Care'.

The Block Protection Status of each block can be read using a Bus Read operation with addresses and control signals set as shown in *Table 3: Bus Operations, BYTE = VIL* and *Table 4: Bus Operations, BYTE = VIH*, except for A9 that is 'Don't Care'. If the addressed block is protected then 01h is output on Data Inputs/Outputs DQ0-DQ7, otherwise 00h is output (in 8-bit mode).

The protection status of the Extended Memory block, or Extended Memory Block Verify code, can be read using a Bus Read operation with addresses and control signals set as shown in *Table 3: Bus Operations, BYTE = VIL* and *Table 4: Bus Operations, BYTE = VIH*, except for A9 that is 'Don't Care'. If the Extended Block is "Factory Locked" then 80h is output on Data Input/Outputs DQ0-DQ7, otherwise 00h is output (8-bit mode).

4.1.3 Read CFI Query command

The Read CFI Query Command is used to read data from the Common Flash Interface (CFI) Memory Area. This command is valid when the device is in the Read Array mode, or when the device is in Autoselected mode.

One Bus Write cycle is required to issue the Read CFI Query Command. Once the command is issued subsequent Bus Read operations read from the Common Flash Interface Memory Area.

The Read/Reset command must be issued to return the device to the previous mode (the Read Array mode or Autoselected mode). A second Read/Reset command would be needed if the device is to be put in the Read Array mode from Autoselected mode.

See *Appendix B: Common Flash Interface (CFI)*, Tables 22, 23, 24, 25, 26 and 27 for details on the information contained in the Common Flash Interface (CFI) memory area.

4.1.4 Chip Erase command

The Chip Erase command can be used to erase the entire chip. Six Bus Write operations are required to issue the Chip Erase Command and start the Program/Erase Controller.

If any blocks are protected then these are ignored and all the other blocks are erased. If all of the blocks are protected the Chip Erase operation appears to start but will terminate within about 100µs, leaving the data unchanged. No error condition is given when protected blocks are ignored.

During the erase operation the memory will ignore all commands, including the Erase Suspend command. It is not possible to issue any command to abort the operation. Typical chip erase times are given in *Table 7: Program, Erase Times and Program, Erase Endurance Cycles*. All Bus Read operations during the Chip Erase operation will output the Status Register on the Data Inputs/Outputs. See the section on the Status Register for more details.

After the Chip Erase operation has completed the memory will return to the Read Mode, unless an error has occurred. When an error occurs the memory will continue to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read Mode.

The Chip Erase Command sets all of the bits in unprotected blocks of the memory to '1'. All previous data is lost.

4.1.5 Block Erase command

The Block Erase command can be used to erase a list of one or more blocks. Six Bus Write operations are required to select the first block in the list. Each additional block in the list can be selected by repeating the sixth Bus Write operation using the address of the additional block. The Block Erase operation starts the Program/Erase Controller about 50µs after the last Bus Write operation. Once the Program/Erase Controller starts it is not possible to select any more blocks. Each additional block must therefore be selected within 50µs of the last block. The 50µs timer restarts when an additional block is selected. The Status Register can be read after the sixth Bus Write operation. See the Status Register section for details on how to identify if the Program/Erase Controller has started the Block Erase operation.

If any selected blocks are protected then these are ignored and all the other selected blocks are erased. If all of the selected blocks are protected the Block Erase operation appears to start but will terminate within about $100\mu s$, leaving the data unchanged. No error condition is given when protected blocks are ignored.

During the Block Erase operation the memory will ignore all commands except the Erase Suspend command. Typical block erase times are given in *Table 7: Program, Erase Times and Program, Erase Endurance Cycles*. All Bus Read operations during the Block Erase operation will output the Status Register on the Data Inputs/Outputs. See the section on the Status Register for more details.

After the Block Erase operation has completed the memory will return to the Read Mode, unless an error has occurred. When an error occurs the memory will continue to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read mode.

The Block Erase Command sets all of the bits in the unprotected selected blocks to '1'. All previous data in the selected blocks is lost.

4.1.6 Erase Suspend command

The Erase Suspend Command may be used to temporarily suspend a Block Erase operation and return the memory to Read mode. The command requires one Bus Write operation.

The Program/Erase Controller will suspend within the Erase Suspend Latency time of the Erase Suspend Command being issued. Once the Program/Erase Controller has stopped the memory will be set to Read mode and the Erase will be suspended. If the Erase Suspend command is issued during the period when the memory is waiting for an additional block (before the Program/Erase Controller starts) then the Erase is suspended immediately and will start immediately when the Erase Resume Command is issued. It is not possible to select any further blocks to erase after the Erase Resume.

During Erase Suspend it is possible to Read and Program cells in blocks that are not being erased; both Read and Program operations behave as normal on these blocks. If any attempt is made to program in a protected block or in the suspended block then the Program command is ignored and the data remains unchanged. The Status Register is not read and no error condition is given. Reading from blocks that are being erased will output the Status Register.

It is also possible to issue the Auto Select, Read CFI Query and Unlock Bypass commands during an Erase Suspend. The Read/Reset command must be issued to return the device to Read Array mode before the Resume command will be accepted.

4.1.7 Erase Resume command

The Erase Resume command must be used to restart the Program/Erase Controller after an Erase Suspend. The device must be in Read Array mode before the Resume command will be accepted. An erase can be suspended and resumed more than once.

4.1.8 Program Suspend command

The Program Suspend command allows the system to interrupt a program operation so that data can be read from any block. When the Program Suspend command is issued during a program operation, the device suspends the program operation within the Program Suspend Latency time (see *Table 7: Program, Erase Times and Program, Erase Endurance Cycles* for value) and updates the Status Register bits.

After the program operation has been suspended, the system can read array data from any address. However, data read from Program-Suspended addresses is not valid.

The Program Suspend command may also be issued during a program operation while an erase is suspended. In this case, data may be read from any addresses not in Erase Suspend

or Program Suspend. If a read is needed from the Extended Block area (One-time Program area), the user must use the proper command sequences to enter and exit this region.

The system may also issue the Auto Select command sequence when the device is in the Program Suspend mode. The system can read as many Auto Select codes as required. When the device exits the Auto Select mode, the device reverts to the Program Suspend mode, and is ready for another valid operation. See Auto Select command sequence for more information.

4.1.9 Program Resume command

After the Program Resume command is issued, the device reverts to programming. The controller can determine the status of the program operation using the DQ7 or DQ6 status bits, just as in the standard program operation. See Write Operation Status for more information.

The system must write the Program Resume command, to exit the Program Suspend mode and to continue the programming operation.

Further issuing of the Resume command is ignored. Another Program Suspend command can be written after the device has resumed programming.

4.1.10 Program command

The Program command can be used to program a value to one address in the memory array at a time. The command requires four Bus Write operations, the final write operation latches the address and data, and starts the Program/Erase Controller.

Programming can be suspended and then resumed by issuing a Program Suspend command and a Program Resume command, respectively (see Section 4.1.8: Program Suspend command and Section 4.1.9: Program Resume command).

If the address falls in a protected block then the Program command is ignored, the data remains unchanged. The Status Register is never read and no error condition is given.

During the program operation the memory will ignore all commands. It is not possible to issue any command to abort or pause the operation. Typical program times are given in *Table 7: Program, Erase Times and Program, Erase Endurance Cycles*. Bus Read operations during the program operation will output the Status Register on the Data Inputs/Outputs. See the section on the Status Register for more details.

After the program operation has completed the memory will return to the Read mode, unless an error has occurred. When an error occurs the memory will continue to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read mode.

Note that the Program command cannot change a bit set at '0' back to '1'. One of the Erase Commands must be used to set all the bits in a block or in the whole memory from '0' to '1'.

4.2 Fast Program commands

There are four Fast Program commands available to improve the programming throughput, by writing several adjacent words or bytes in parallel. The Double, Quadruple and Octuple Byte Program commands are available for x8 operations, while the Double Quadruple Word Program command are available for x16 operations.

Fast Program commands can be suspended and then resumed by issuing a Program Suspend command and a Program Resume command, respectively (see Section 4.1.8: Program Suspend command and Section 4.1.9: Program Resume command).

When V_{PPH} is applied to the V_{PP} /Write Protect pin the memory automatically enters the Fast Program mode. The user can then choose to issue any of the Fast Program commands. Care must be taken because applying a V_{PPH} to the V_{PP} /WP pin will temporarily unprotect any protected block.

4.2.1 Double Byte Program command

The Double Byte Program command is used to write a page of two adjacent Bytes in parallel. The two bytes must differ only in DQ15A-1. Three bus write cycles are necessary to issue the Double Byte Program command.

- 1. The first bus cycle sets up the Double Byte Program Command.
- 2. The second bus cycle latches the Address and the Data of the first byte to be written.
- 3. The third bus cycle latches the Address and the Data of the second byte to be written.

4.2.2 Quadruple Byte Program command

The Quadruple Byte Program command is used to write a page of four adjacent Bytes in parallel. The four bytes must differ only for addresses A0, DQ15A-1. Five bus write cycles are necessary to issue the Quadruple Byte Program command.

- 1. The first bus cycle sets up the Quadruple Byte Program Command.
- 2. The second bus cycle latches the Address and the Data of the first byte to be written.
- 3. The third bus cycle latches the Address and the Data of the second byte to be written.
- 4. The fourth bus cycle latches the Address and the Data of the third byte to be written.
- 5. The fifth bus cycle latches the Address and the Data of the fourth byte to be written and starts the Program/Erase Controller.

4.2.3 Octuple Byte Program command

This is used to write eight adjacent Bytes, in x8 mode, simultaneously. The addresses of the eight Bytes must differ only in A1, A0 and DQ15A-1.

Nine bus write cycles are necessary to issue the command:

- The first bus cycle sets up the command.
- 2. The second bus cycle latches the Address and the Data of the first Byte to be written.
- 3. The third bus cycle latches the Address and the Data of the second Byte to be written.
- 4. The fourth bus cycle latches the Address and the Data of the third Byte to be written.
- 5. The fifth bus cycle latches the Address and the Data of the fourth Byte to be written.
- 6. The sixth bus cycle latches the Address and the Data of the fifth Byte to be written.
- 7. The seventh bus cycle latches the Address and the Data of the sixth Byte to be written.
- 8. The eighth bus cycle latches the Address and the Data of the seventh Byte to be written.
- The ninth bus cycle latches the Address and the Data of the eighth Byte to be written and starts the Program/Erase Controller.

4.2.4 Double Word Program command

The Double Word Program command is used to write a page of two adjacent Words in parallel. The two Words must differ only for the address A0.

Three bus write cycles are necessary to issue the Double Word Program command.

- The first bus cycle sets up the Quadruple Word Program Command.
- The second bus cycle latches the Address and the Data of the first Word to be written.
- The third bus cycle latches the Address and the Data of the second Word to be written and starts the Program/Erase Controller.

After the program operation has completed the memory will return to the Read mode, unless an error has occurred. When an error occurs Bus Read operations will continue to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read mode.

Note that the Fast Program commands cannot change a bit set at '0' back to '1'. One of the Erase Commands must be used to set all the bits in a block or in the whole memory from '0' to '1'.

Typical Program times are given in *Table 7: Program, Erase Times and Program, Erase Endurance Cycles*.

4.2.5 Quadruple Word Program command

This is used to write a page of four adjacent Words (or 8 adjacent Bytes), in x16 mode, simultaneously. The addresses of the four Words must differ only in A1 and A0.

Five bus write cycles are necessary to issue the command:

- The first bus cycle sets up the command.
- The second bus cycle latches the Address and the Data of the first Word to be written.
- The third bus cycle latches the Address and the Data of the second Word to be written.
- The fourth bus cycle latches the Address and the Data of the third Word to be written.
- The fifth bus cycle latches the Address and the Data of the fourth Word to be written and starts the Program/Erase Controller.

4.2.6 Unlock Bypass command

The Unlock Bypass command is used in conjunction with the Unlock Bypass Program command to program the memory faster than with the standard program commands. When the cycle time to the device is long, considerable time saving can be made by using these commands. Three Bus Write operations are required to issue the Unlock Bypass command.

Once the Unlock Bypass command has been issued the memory will only accept the Unlock Bypass Program command and the Unlock Bypass Reset command. The memory can be read as if in Read mode.

When V_{PP} is applied to the V_{PP} /Write Protect pin the memory automatically enters the Unlock Bypass mode and the Unlock Bypass Program command can be issued immediately.

4.2.7 Unlock Bypass Program command

The Unlock Bypass command is used in conjunction with the Unlock Bypass Program command to program the memory. When the cycle time to the device is long, considerable time saving can be made by using these commands. Three Bus Write operations are required to issue the Unlock Bypass command.

Once the Unlock Bypass command has been issued the memory will only accept the Unlock Bypass Program command and the Unlock Bypass Reset command. The memory can be read as if in Read mode.

The memory offers accelerated program operations through the V_{PP} /Write Protect pin. When the system asserts V_{PP} on the V_{PP} /Write Protect pin, the memory automatically enters the Unlock Bypass mode. The system may then write the two-cycle Unlock Bypass program command sequence. The memory uses the higher voltage on the V_{PP} /Write Protect pin, to accelerate the Unlock Bypass Program operation.

Never raise V_{PP} /Write Protect to V_{PP} from any mode except Read mode, otherwise the memory may be left in an indeterminate state.

4.2.8 Unlock Bypass Reset command

The Unlock Bypass Reset command can be used to return to Read/Reset mode from Unlock Bypass Mode. Two Bus Write operations are required to issue the Unlock Bypass Reset command. Read/Reset command does not exit from Unlock Bypass Mode.

4.3 Block Protection commands

4.3.1 Enter Extended Block command

The device has an extra 256 Byte block (Extended Block) that can only be accessed using the Enter Extended Block command. Three Bus write cycles are required to issue the Extended Block command. Once the command has been issued the device enters Extended Block mode where all Bus Read or Write operations to the Boot Block addresses access the Extended Block. The Extended Block (with the same address as the Boot Blocks) cannot be erased, and can be treated as one-time programmable (OTP) memory. In Extended Block mode the Boot Blocks are not accessible.

To exit from the Extended Block mode the Exit Extended Block command must be issued.

The Extended Block can be protected, however once protected the protection cannot be undone.

4.3.2 Exit Extended Block command

The Exit Extended Block command is used to exit from the Extended Block mode and return the device to Read mode. Four Bus Write operations are required to issue the command.

4.3.3 **Block Protect and Chip Unprotect commands**

Groups of blocks can be protected against accidental Program or Erase. The Protection Groups are shown in Appendix A: Block addresses, Table 20: Top Boot Block Addresses, M29W640FT and Table 21: Bottom Boot Block Addresses, M29W640FB. The whole chip can be unprotected to allow the data inside the blocks to be changed.

Block Protect and Chip Unprotect operations are described in Appendix D: Block Protection.

Commands, 16-bit mode, $\overline{BYTE} = V_{IH}$ Table 5.

	Length	Bus Write Operations													
Command		1st		2r	2nd		3rd		4th		5th		h		
		Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data		
Read/Reset	1	Х	F0												
Read/Reset	3	555	AA	2AA	55	Х	F0								
Auto Select	3	555	AA	2AA	55	555	90								
Program	4	555	AA	2AA	55	555	A0	PA	PD						
Double Word Program	3	555	50	PA0	PD0	PA1	PD1								
Quadruple Word Program	5	555	56	PA0	PD0	PA1	PD1	PA2	PD2	PA3	PD3				
Unlock Bypass	3	555	AA	2AA	55	555	20								
Unlock Bypass Program	2	Х	Α0	PA	PD										
Unlock Bypass Reset	2	Х	90	Х	00										
Chip Erase	6	555	AA	2AA	55	555	80	555	AA	2AA	55	555	10		
Block Erase	6+	555	AA	2AA	55	555	80	555	AA	2AA	55	ВА	30		
Program/Erase Suspend	1	Х	В0												
Program/Erase Resume	1	Х	30												
Read CFI Query	1	55	98												
Enter Extended Block	3	555	AA	2AA	55	555	88								
Exit Extended Block	4	555	AA	2AA	55	555	90	Х	00						

^{1.} X Don't Care, PA Program Address, PD Program Data, BA Any address in the Block. All values in the table are in

57

hexadecimal.

The Command Interface only uses A–1, A0-A10 and DQ0-DQ7 to verify the commands; A11-A20, DQ8-DQ14 and DQ15 are Don't Care. DQ15A–1 is A–1 when BYTE is V_{IL} or DQ15 when BYTE is V_{IH}.

Commands, 8-bit mode, $\overline{\text{BYTE}} = V_{II}$ Table 6.

									Bus	Write	Operat	ions							
Command	enath	¹ 1st		2nd		3rd		4	4th		5th		6th		7th		8th		th
	-	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data
Read/Reset	1	Χ	F0																
Neau/Neset	3	AAA	AA	555	55	Х	F0												
Auto Select	3	AAA	AA	555	55	AAA	90												
Program	4	AAA	AA	555	55	AAA	A0	PA	PD										
Double Byte Program	3	AAA	50	PA0	PD0	PA1	PD1	PA2	PD2										
Quadruple Byte Program	5	AAA	56	PA0	PD0	PA1	PD1	PA2	PD2	PA3	PD3								
Octuple Byte Program	9	AAA	8B	PA0	PD0	PA1	PD1	PA2	PD2	PA3	PD3	PA4	PD4	PA5	PD5	PA6	PD6	PA7	PD7
Unlock Bypass	3	AAA	AA	555	55	AAA	20												
Unlock Bypass Program	2	х	A0	PA	PD														
Unlock Bypass Reset	2	Х	90	Х	00														
Chip Erase	6	AAA	AA	555	55	AAA	80	AAA	AA	555	55	AAA	10						
Block Erase	6 +	AAA	АА	555	55	AAA	80	AAA	АА	555	55	ВА	30						
Program/ Erase Suspend	1	Х	В0																
Program/ Erase Resume	1	Х	30																
Read CFI Query	1	AA	98																
Enter Extended Block	3	AAA	AA	555	55	AAA	88												
Exit Extended Block	4	AAA	AA	555	55	AAA	90	Х	00										

X Don't Care, PA Program Address, PD Program Data, BA Any address in the Block. All values in the table are in hexadecimal.
 The Command Interface only uses A-1, A0-A10 and DQ0-DQ7 to verify the commands; A11-A20, DQ8-DQ14 and DQ15 are Don't Care. DQ15A-1 is A-1 when BYTE is V_{IL} or DQ15 when BYTE is V_{IH}.

Table 7. Program, Erase Times and Program, Erase Endurance Cycles

Parameter	Min	Typ ^{(1) (2)}	Max ⁽²⁾	Unit
Chip Erase		80	400 ⁽³⁾	s
Block Erase (64 KBytes)		0.8	6 ⁽⁴⁾	s
Erase Suspend Latency Time			50 ⁽⁴⁾	μs
Program (Byte or Word)		10	200 ⁽³⁾	μs
Double Byte		10	200 ⁽³⁾	μs
Double Word /Quadruple Byte Program		10	200 ⁽³⁾	μs
Quadruple Word / Octuple Byte Program		10	200 ⁽³⁾	μs
Chip Program (Byte by Byte)		80	400 ⁽³⁾	s
Chip Program (Word by Word)		40	200 ⁽³⁾	s
Chip Program (Double Word/Quadruple Byte Program)		20	100 ⁽³⁾	s
Chip Program (Quadruple Word/Octuple Byte Program)		10	50 ⁽³⁾	s
Program Suspend Latency Time			4	μs
Program/Erase Cycles (per Block)	100,000			cycles
Data Retention	20			years

^{1.} Typical values measured at room temperature and nominal voltages.

^{2.} Sampled, but not 100% tested.

^{3.} Maximum value measured at worst case conditions for both temperature and V_{CC} after 100,00 program/erase cycles.

^{4.} Maximum value measured at worst case conditions for both temperature and V_{CC} .

5 Status Register

Bus Read operations from any address always read the Status Register during Program and Erase operations. It is also read during Erase Suspend when an address within a block being erased is accessed.

The bits in the Status Register are summarized in Table 8: Status Register Bits.

5.1 Data Polling Bit (DQ7)

The Data Polling Bit can be used to identify whether the Program/Erase Controller has successfully completed its operation or if it has responded to an Erase Suspend. The Data Polling Bit is output on DQ7 when the Status Register is read.

During Program operations the Data Polling Bit outputs the complement of the bit being programmed to DQ7. After successful completion of the Program operation the memory returns to Read mode and Bus Read operations from the address just programmed output DQ7, not its complement.

During Erase operations the Data Polling Bit outputs '0', the complement of the erased state of DQ7. After successful completion of the Erase operation the memory returns to Read Mode.

In Erase Suspend mode the Data Polling Bit will output a '1' during a Bus Read operation within a block being erased. The Data Polling Bit will change from a '0' to a '1' when the Program/ Erase Controller has suspended the Erase operation.

Figure 4: Data Polling Flowchart, gives an example of how to use the Data Polling Bit. A Valid Address is the address being programmed or an address within the block being erased.

5.2 Toggle Bit (DQ6)

The Toggle Bit can be used to identify whether the Program/Erase Controller has successfully completed its operation or if it has responded to an Erase Suspend. The Toggle Bit is output on DQ6 when the Status Register is read.

During Program and Erase operations the Toggle Bit changes from '0' to '1' to '0', etc., with successive Bus Read operations at any address. After successful completion of the operation the memory returns to Read mode.

During Erase Suspend mode the Toggle Bit will output when addressing a cell within a block being erased. The Toggle Bit will stop toggling when the Program/Erase Controller has suspended the Erase operation.

Figure 5: Data Toggle Flowchart, gives an example of how to use the Data Toggle Bit.

5.3 Error Bit (DQ5)

The Error Bit can be used to identify errors detected by the Program/Erase Controller. The Error Bit is set to '1' when a Program, Block Erase or Chip Erase operation fails to write the correct data to the memory. If the Error Bit is set a Read/Reset command must be issued before other commands are issued. The Error bit is output on DQ5 when the Status Register is read.

Note that the Program command cannot change a bit set to '0' back to '1' and attempting to do so will set DQ5 to '1'. A Bus Read operation to that address will show the bit is still '0'. One of the Erase commands must be used to set all the bits in a block or in the whole memory from '0' to '1'.

5.4 Erase Timer Bit (DQ3)

The Erase Timer Bit can be used to identify the start of Program/Erase Controller operation during a Block Erase command. Once the Program/Erase Controller starts erasing the Erase Timer Bit is set to '1'. Before the Program/Erase Controller starts the Erase Timer Bit is set to '0' and additional blocks to be erased may be written to the Command Interface. The Erase Timer Bit is output on DQ3 when the Status Register is read.

5.5 Alternative Toggle Bit (DQ2)

The Alternative Toggle Bit can be used to monitor the Program/Erase controller during Erase operations. The Alternative Toggle Bit is output on DQ2 when the Status Register is read.

During Chip Erase and Block Erase operations the Toggle Bit changes from '0' to '1' to '0', etc., with successive Bus Read operations from addresses within the blocks being erased. A protected block is treated the same as a block not being erased. Once the operation completes the memory returns to Read mode.

During Erase Suspend the Alternative Toggle Bit changes from '0' to '1' to '0', etc. with successive Bus Read operations from addresses within the blocks being erased. Bus Read operations to addresses within blocks not being erased will output the memory cell data as if in Read mode.

After an Erase operation that causes the Error Bit to be set the Alternative Toggle Bit can be used to identify which block or blocks have caused the error. The Alternative Toggle Bit changes from '0' to '1' to '0', etc. with successive Bus Read Operations from addresses within blocks that have not erased correctly. The Alternative Toggle Bit does not change if the addressed block has erased correctly.

Table 8. Status Register Bits

Table 6. Clarus Neglater Dita							
Operation	Address	DQ7	DQ6	DQ5	DQ3	DQ2	$R\overline{B}$
Program	Any Address	DQ7	Toggle	0	-	-	0
Program During Erase Suspend	Any Address	DQ7	Toggle	0	-	-	0
Program Error	Any Address	DQ7	Toggle	1	-	_	Hi-Z
Chip Erase	Any Address	0	Toggle	0	1	Toggle	Hi-Z
Block Erase before timeout	Erasing Block	0	Toggle	0	0	Toggle	0
	Non-Erasing Block	0	Toggle	0	0	No Toggle	0
Block Erase	Erasing Block	0	Toggle	0	1	Toggle	Hi-Z
	Non-Erasing Block	0	Toggle	0	1	No Toggle	0
Erase Suspend	Erasing Block	1	No Toggle	0	-	Toggle	Hi-Z
	Non-Erasing Block		Data	read as no	ormal		Hi-Z
Erase Error	Good Block Address	0	Toggle	1	1	No Toggle	0
	Faulty Block Address	0	Toggle	1	1	Toggle	0

^{1.} Unspecified data bits should be ignored.

Figure 4. Data Polling Flowchart

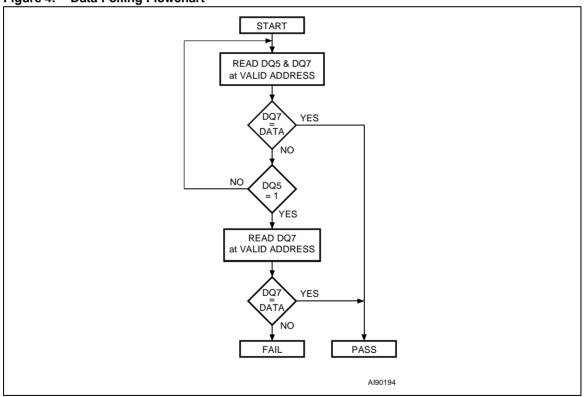
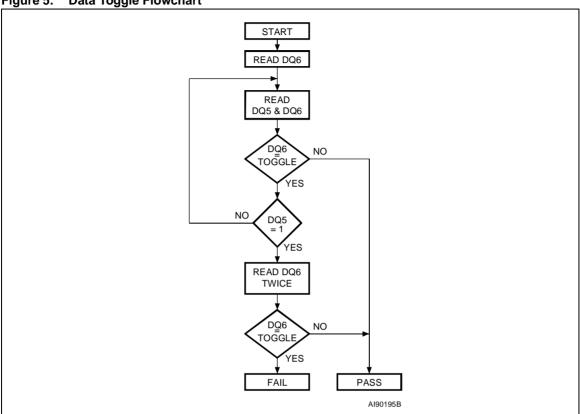


Figure 5. Data Toggle Flowchart



6 Maximum rating

Stressing the device above the rating listed in the Absolute Maximum Ratings table may cause permanent damage to the device. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 9. Absolute Maximum Ratings

Symbol	Parameter	Min	Max	Unit
T _{BIAS}	Temperature Under Bias	-50	125	°C
T _{STG}	Storage Temperature	– 65	150	°C
V _{IO}	Input or Output Voltage ⁽¹⁾⁽²⁾	-0.6	V _{CC} +0.6	V
V _{CC}	Supply Voltage	-0.6	4	V
V _{ID}	Identification Voltage	-0.6	13.5	V
V _{PP} ⁽³⁾	Program Voltage	-0.6	13.5	V

^{1.} Minimum voltage may undershoot to –2V during transition and for less than 20ns during transitions.

^{2.} Maximum voltage may overshoot to V_{CC} +2V during transition and for less than 20ns during transitions.

^{3.} V_{PP} must not remain at 12V for more than a total of 80hrs.

7 DC and AC parameters

This section summarizes the operating and measurement conditions, and the DC and AC characteristics of the device. The parameters in the DC and AC Characteristic tables that follow are derived from tests performed under the Measurement Conditions summarized in the relevant tables. Designers should check that the operating conditions in their circuit match the measurement conditions when relying on the quoted parameters.

Table 10. Operating and AC Measurement Conditions

Parameter	M29W640FT,	M29W640FT, M29W640FB		
Farameter	Min	Max		
V _{CC} Supply Voltage	2.7	3.6	V	
Ambient Operating Temperature	-40	85	°C	
Load Capacitance (C _L)	3	30		
Input Rise and Fall Times		10	ns	
Input Pulse Voltages	0 to	0 to V _{CC}		
Input and Output Timing Ref. Voltages	V _C	V _{CC} /2		

Figure 6. AC Measurement I/O Waveform

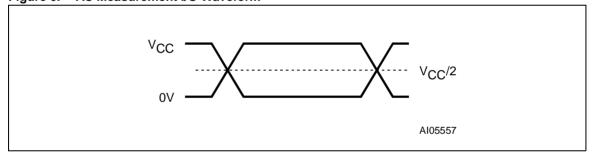


Figure 7. AC Measurement Load Circuit

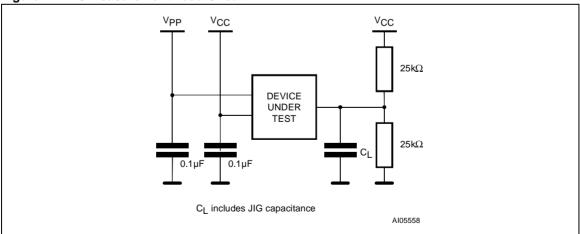


Table 11. Device Capacitance

Symbol	Parameter	Test Condition	Min	Max	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V		6	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V		12	pF

^{1.} Sampled only, not 100% tested.

Table 12. DC Characteristics

Symbol	Parameter	Test Condition		Min	Max	Unit	
I _{LI}	Input Leakage Current	0V ≤V _{IN} ≤V _{CC}			±1	μA	
I _{LO}	Output Leakage Current	0V ≤V _{OU}	T ≤V _{CC}		±1	μA	
I _{CC1}	Supply Current (Read)	$\overline{E} = V_{IL}, \overline{G} = V_{IH},$ $f = 6MHz$			10	mA	
I _{CC2}	Supply Current (Standby)	$\overline{E} = V_{CC} \pm 0.2V,$ $\overline{RP} = V_{CC} \pm 0.2V$			100	μΑ	
I _{CC3}	Supply Current (Program/ Erase)	Program/Erase Controller active	upply Current (Program/ Program/Erase V _{II}	$V_{PP}/\overline{WP} = V_{IL} \text{ or } V_{IH}$		20	mA
	[21400]		$V_{PP}/\overline{WP} = V_{PP}$		20	mA	
V _{IL}	Input Low Voltage			-0.5	0.8	V	
V _{IH}	Input High Voltage			0.7V _{CC}	V _{CC} +0.3	V	
V _{PP}	Voltage for V _{PP} /WP Program Acceleration	V _{CC} = 2.7V ±10%		11.5	12.5	V	
I _{PP}	Current for V _{PP} /WP Program Acceleration	V _{CC} = 2.7V ±10%			15	mA	
V _{OL}	Output Low Voltage	I _{OL} = 1.8mA			0.45	V	
V _{OH}	Output High Voltage	I _{OH} = -100μA		V _{CC} -0.4		V	
V _{ID}	Identification Voltage			11.5	12.5	V	
V _{LKO} ⁽¹⁾	Program/Erase Lockout Supply Voltage			1.8	2.3	V	

^{1.} Sampled only, not 100% tested.

Figure 8. Read Mode AC Waveforms

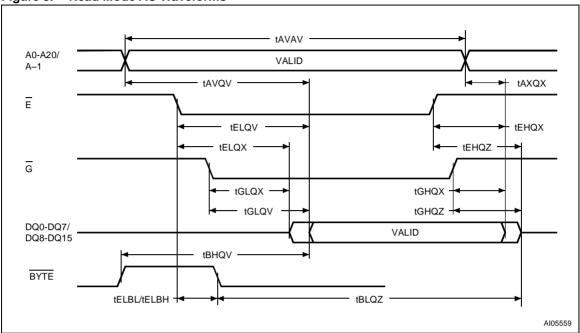


Figure 9. Page Read AC Waveforms

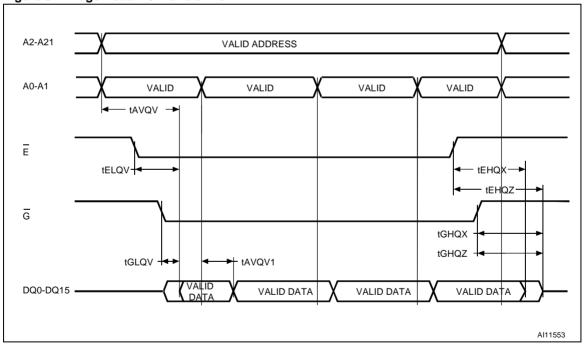


Table 13. Read AC Characteristics

Symbol Alt		Parameter	Test Condition		M29W640FT, M29W640FB		Unit
				<u> </u>		70] !
t _{AVAV}	t _{RC}	Address Valid to Next Address Valid	$\overline{E} = V_{IL},$ $\overline{G} = V_{IL}$	Min	60	70	ns
t _{AVQV}	t _{ACC}	Address Valid to Output Valid	$\overline{E} = V_{IL},$ $\overline{G} = V_{IL}$	Max	60	70	ns
t _{AVQV1}	t _{PAGE}	Address Valid to Output Valid (Page)	$\overline{E} = V_{IL},$ $\overline{G} = V_{IL}$	Max	25	25	ns
t _{ELQX} ⁽¹⁾	t_{LZ}	Chip Enable Low to Output Transition	$\overline{G} = V_{IL}$	Min	0	0	ns
t _{ELQV}	t _{CE}	Chip Enable Low to Output Valid	$\overline{G} = V_{IL}$	Max	60	70	ns
t _{GLQX} ⁽¹⁾	t _{OLZ}	Output Enable Low to Output Transition	$\overline{E} = V_{IL}$	Min	0	0	ns
t _{GLQV}	t _{OE}	Output Enable Low to Output Valid	$\overline{E} = V_{IL}$	Max	25	25	ns
t _{EHQZ} (1)	t _{HZ}	Chip Enable High to Output Hi-Z	$\overline{G} = V_{IL}$	Max	25	25	ns
t _{GHQZ} ⁽¹⁾	t _{DF}	Output Enable High to Output Hi-Z	$\overline{E} = V_{IL}$	Max	25	25	ns
t _{EHQX} t _{GHQX} t _{AXQX}	t _{OH}	Chip Enable, Output Enable or Address Transition to Output Transition		Min	0	0	ns
t _{ELBL} t _{ELBH}	t _{ELFL}	Chip Enable to BYTE Low or High		Max	5	5	ns
t _{BLQZ}	t _{FLQZ}	BYTE Low to Output Hi-Z		Max	25	25	ns
t _{BHQV}	t _{FHQV}	BYTE High to Output Valid		Max	30	30	ns

^{1.} Sampled only, not 100% tested.

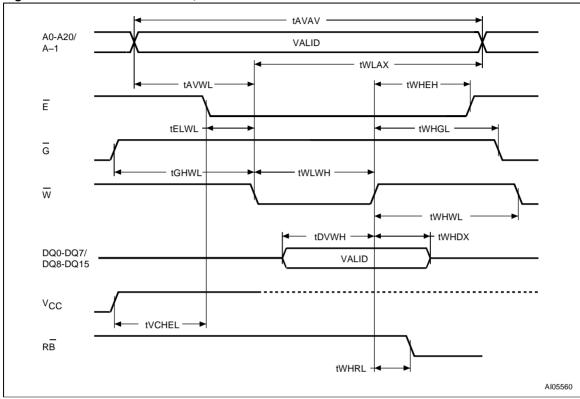


Figure 10. Write AC Waveforms, Write Enable Controlled

Table 14. Write AC Characteristics, Write Enable Controlled

Symbol	Alt	Parameter			M29W640FT, M29W640FB		
				60	70		
t _{AVAV}	t _{WC}	Address Valid to Next Address Valid	Min	60	70	ns	
t _{ELWL}	t _{CS}	Chip Enable Low to Write Enable Low	Min	0	0	ns	
t _{WLWH}	t _{WP}	Write Enable Low to Write Enable High	Min	45	45	ns	
t _{DVWH}	t _{DS}	Input Valid to Write Enable High	Min	45	45	ns	
t _{WHDX}	t _{DH}	Write Enable High to Input Transition	Min	0	0	ns	
t _{WHEH}	t _{CH}	Write Enable High to Chip Enable High	Min	0	0	ns	
t _{WHWL}	t _{WPH}	Write Enable High to Write Enable Low	Min	30	30	ns	
t _{AVWL}	t _{AS}	Address Valid to Write Enable Low	Min	0	0	ns	
t _{WLAX}	t _{AH}	Write Enable Low to Address Transition	Min	45	45	ns	
t _{GHWL}		Output Enable High to Write Enable Low	Min	0	0	ns	
t _{WHGL}	t _{OEH}	Write Enable High to Output Enable Low	Min	0	0	ns	
t _{WHRL} ⁽¹⁾	t _{BUSY}	Program/Erase Valid to RB Low	Max	30	30	ns	
t _{VCHEL}	t _{VCS}	V _{CC} High to Chip Enable Low	Min	50	50	μs	

^{1.} Sampled only, not 100% tested.

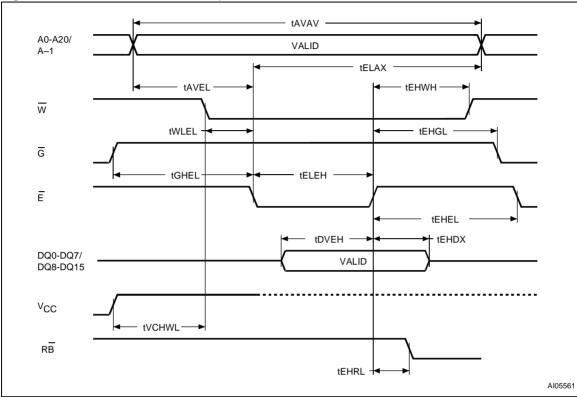


Figure 11. Write AC Waveforms, Chip Enable Controlled

Table 15. Write AC Characteristics, Chip Enable Controlled

Symbol Alt		Parameter	M29W640FT,	M29W640FB	Unit	
Symbol	AIL	Farameter	60	70	Unit	
t _{AVAV}	t _{WC}	Address Valid to Next Address Valid	Min	60	70	ns
t _{WLEL}	t _{WS}	Write Enable Low to Chip Enable Low	Min	0	0	ns
t _{ELEH}	t _{CP}	Chip Enable Low to Chip Enable High	Min	45	45	ns
t _{DVEH}	t _{DS}	Input Valid to Chip Enable High	Min	45	45	ns
t _{EHDX}	t _{DH}	Chip Enable High to Input Transition	Min	0	0	ns
t _{EHWH}	t _{WH}	Chip Enable High to Write Enable High	Min	0	0	ns
t _{EHEL}	t _{CPH}	Chip Enable High to Chip Enable Low	Min	30	30	ns
t _{AVEL}	t _{AS}	Address Valid to Chip Enable Low	Min	0	0	ns
t _{ELAX}	t _{AH}	Chip Enable Low to Address Transition	Min	45	45	ns
t _{GHEL}		Output Enable High Chip Enable Low	Min	0	0	ns
t _{EHGL}	t _{OEH}	Chip Enable High to Output Enable Low	Min	0	0	ns
t _{EHRL} ⁽¹⁾	t _{BUSY}	Program/Erase Valid to RB Low	Max	30	30	ns
t _{VCHWL}	t _{VCS}	V _{CC} High to Write Enable Low	Min	50	50	μs

^{1.} Sampled only, not 100% tested.

W, E, G

RB

tPHWL, tPHGL

tRHWL, tRHEL, tRHGL

RP

tPLPX

Al02931B

Figure 12. Reset/Block Temporary Unprotect AC Waveforms

Figure 13. Accelerated Program Timing Waveforms

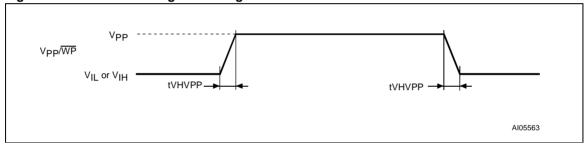


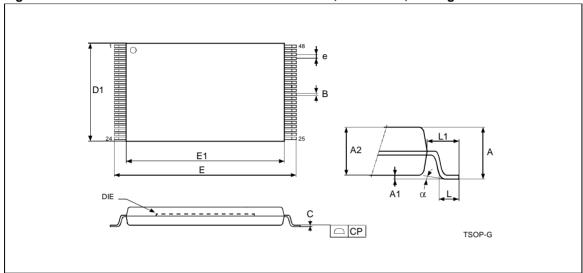
Table 16. Reset/Block Temporary Unprotect AC Characteristics

Symbol	Alt	Parameter	M29W640FT, M29W640FB	Unit	
t _{PHWL} ⁽¹⁾ t _{PHEL} t _{PHGL} ⁽¹⁾	t _{RH}	RP High to Write Enable Low, Chip Enable Low, Output Enable Low	Min	50	ns
t _{RHWL} ⁽¹⁾ t _{RHEL} ⁽¹⁾ t _{RHGL} ⁽¹⁾	t _{RB}	RB High to Write Enable Low, Chip Enable Low, Output Enable Low	Min	0	ns
t _{PLPX}	t _{RP}	RP Pulse Width	Min	500	ns
t _{PLYH}	t _{READY}	RP Low to Read Mode	Max	50	μs
t _{PHPHH} ⁽¹⁾	t _{VIDR}	RP Rise Time to V _{ID}	Min	500	ns
t _{VHVPP} ⁽¹⁾		V _{PP} Rise and Fall Time	Min	250	ns

^{1.} Sampled only, not 100% tested.

8 Package mechanical

Figure 14. TSOP48 – 48 lead Plastic Thin Small Outline, 12 x 20mm, Package Outline



^{1.} Drawing is not to scale.

Table 17. TSOP48 – 48 lead Plastic Thin Small Outline, 12 x 20mm, Package Mechanical Data

Symbol		millimeters			inches		
Symbol	Тур	Min	Max	Тур	Min	Max	
А			1.200			0.0472	
A1	0.100	0.050	0.150	0.0039	0.0020	0.0059	
A2	1.000	0.950	1.050	0.0394	0.0374	0.0413	
В	0.220	0.170	0.270	0.0087	0.0067	0.0106	
С		0.100	0.210		0.0039	0.0083	
СР			0.100			0.0039	
D1	12.000	11.900	12.100	0.4724	0.4685	0.4764	
Е	20.000	19.800	20.200	0.7874	0.7795	0.7953	
E1	18.400	18.300	18.500	0.7244	0.7205	0.7283	
е	0.500	_	_	0.0197	_	_	
L	0.600	0.500	0.700	0.0236	0.0197	0.0276	
L1	0.800			0.0315			
а	3	0	5	3	0	5	

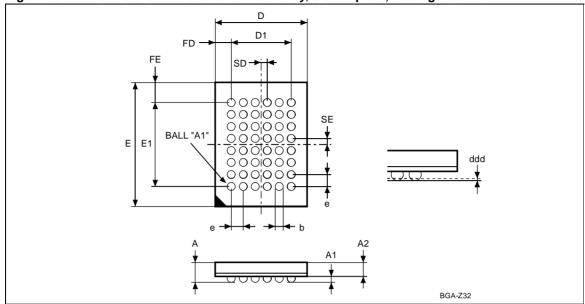


Figure 15. TFBGA48 6x8mm - 6x8 active ball array, 0.8mm pitch, Package Outline

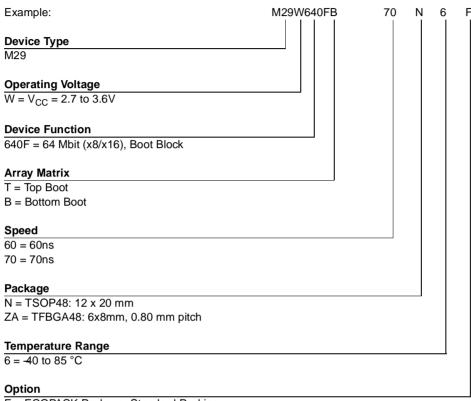
1. Drawing is not to scale.

Table 18. TFBGA48 6x8mm - 6x8 active ball array, 0.8mm pitch, Package Mechanical Data

Cumbal		millimeters		inches			
Symbol	Тур	Min	Max	Тур	Min	Max	
А			1.200			0.0472	
A1		0.260			0.0102		
A2			0.900			0.0354	
b		0.350	0.450		0.0138	0.0177	
D	6.000	5.900	6.100	0.2362	0.2323	0.2402	
D1	4.000	-	-	0.1575	_	-	
ddd			0.100			0.0039	
Е	8.000	7.900	8.100	0.3150	0.3110	0.3189	
E1	5.600	-	-	0.2205	_	-	
е	0.800	-	-	0.0315	_	-	
FD	1.000	-	-	0.0394	-	-	
FE	1.200	-	-	0.0472	_	-	
SD	0.400	-	-	0.0157	-	-	
SE	0.400	-	-	0.0157	_	-	

9 Part Numbering

Table 19. Ordering Information Scheme



E = ECOPACK Package, Standard Packing F = ECOPACK Package, Tape & Reel Packing

Note: This product is also available with the Extended Block factory locked. For further details and ordering information contact your nearest ST sales office.

Devices are shipped from the factory with the memory content bits erased to 1. For a list of available options (Speed, Package, etc.) or for further information on any aspect of this device, please contact your nearest ST Sales Office.

Appendix A Block addresses

Table 20. Top Boot Block Addresses, M29W640FT

Table 20.	Table 20. Top Boot Block Addresses, M29W640FT						
Block	KBytes/ KWords	Protection Block Group	(x8)	(x16)			
0	64/32		000000h-00FFFh ⁽¹⁾	000000h-007FFFh ⁽¹⁾			
1	64/32	Protection Group	010000h-01FFFFh	008000h-00FFFFh			
2	64/32	- 1 Totection Group	020000h-02FFFFh	010000h-017FFFh			
3	64/32	7	030000h-03FFFFh	018000h-01FFFFh			
4	64/32		040000h-04FFFFh	020000h-027FFFh			
5	64/32	Brotoction Croup	050000h-05FFFFh	028000h-02FFFFh			
6	64/32	Protection Group	060000h-06FFFFh	030000h-037FFFh			
7	64/32	7	070000h-07FFFFh	038000h-03FFFFh			
8	64/32		080000h-08FFFFh	040000h-047FFFh			
9	64/32	Protection Group	090000h-09FFFh	048000h-04FFFFh			
10	64/32	- Protection Group	0A0000h-0AFFFFh	050000h-057FFFh			
11	64/32		0B0000h-0BFFFFh	058000h-05FFFFh			
12	64/32		0C0000h-0CFFFFh	060000h-067FFFh			
13	64/32	Protection Group	0D0000h-0DFFFFh	068000h-06FFFFh			
14	64/32	- Flotection Gloup	0E0000h-0EFFFFh	070000h-077FFFh			
15	64/32	7	0F0000h-0FFFFh	078000h-07FFFFh			
16	64/32		100000h-10FFFFh	080000h-087FFFh			
17	64/32	Drataction Croup	110000h-11FFFFh	088000h-08FFFFh			
18	64/32	Protection Group	120000h-12FFFFh	090000h-097FFh			
19	64/32	7	130000h-13FFFFh	098000h-09FFFFh			
20	64/32		140000h-14FFFFh	0A0000h-0A7FFFh			
21	64/32	Drata etian Crown	150000h-15FFFFh	0A8000h-0AFFFFh			
22	64/32	Protection Group	160000h-16FFFFh	0B0000h-0B7FFFh			
23	64/32] [170000h-17FFFFh	0B8000h-0BFFFFh			
24	64/32		180000h-18FFFFh	0C0000h-0C7FFFh			
25	64/32	Brotoction Croup	190000h-19FFFFh	0C8000h-0CFFFFh			
26	64/32	Protection Group	1A0000h-1AFFFFh	0D0000h-0D7FFFh			
27	64/32] [1B0000h-1BFFFFh	0D8000h-0DFFFFh			



Block	KBytes/ KWords	Protection Block Group	(x8)	(x16)
28	64/32		1C0000h-1CFFFFh	0E0000h-0E7FFh
29	64/32	Protection Craus	1D0000h-1DFFFFh	0E8000h-0EFFFFh
30	64/32	Protection Group	1E0000h-1EFFFFh	0F0000h-0F7FFFh
31	64/32		1F0000h-1FFFFFh	0F8000h-0FFFFFh
32	64/32		200000h-20FFFFh	100000h-107FFFh
33	64/32		210000h-21FFFFh	108000h-10FFFFh
34	64/32	Protection Group	220000h-22FFFFh	110000h-117FFFh
35	64/32		230000h-23FFFFh	118000h-11FFFFh
36	64/32		240000h-24FFFFh	120000h-127FFFh
37	64/32		250000h-25FFFFh	128000h-12FFFFh
38	64/32	Protection Group	260000h-26FFFFh	130000h-137FFFh
39	64/32		270000h-27FFFh	138000h-13FFFFh
40	64/32		280000h-28FFFFh	140000h-147FFFh
41	64/32	Danta ation Comm	290000h-29FFFFh	148000h-14FFFFh
42	64/32	Protection Group	2A0000h-2AFFFFh	150000h-157FFFh
43	64/32	7	2B0000h-2BFFFFh	158000h-15FFFFh
44	64/32		2C0000h-2CFFFFh	160000h-167FFFh
45	64/32	Basto stiere Occurs	2D0000h-2DFFFFh	168000h-16FFFFh
46	64/32	Protection Group	2E0000h-2EFFFFh	170000h-177FFFh
47	64/32		2F0000h-2FFFFFh	178000h-17FFFFh
48	64/32		300000h-30FFFFh	180000h-187FFFh
49	64/32		310000h-31FFFFh	188000h-18FFFFh
50	64/32	Protection Group	320000h-32FFFFh	190000h-197FFFh
51	64/32	7	330000h-33FFFFh	198000h-19FFFFh
52	64/32		340000h-34FFFFh	1A0000h-1A7FFFh
53	64/32	Drotooties Crave	350000h-35FFFFh	1A8000h-1AFFFFh
54	64/32	Protection Group	360000h-36FFFFh	1B0000h-1B7FFFh
55	64/32	7	370000h-37FFFFh	1B8000h-1BFFFFh
56	64/32		380000h-38FFFFh	1C0000h-1C7FFFh
57	64/32	Drotootics Crows	390000h-39FFFFh	1C8000h-1CFFFFh
58	64/32	Protection Group	3A0000h-3AFFFFh	1D0000h-1D7FFFh
59	64/32		3B0000h-3BFFFFh	1D8000h-1DFFFFh

Block	KBytes/ KWords	Protection Block Group	(x8)	(x16)
60	64/32		3C0000h-3CFFFFh	1E0000h-1E7FFFh
61	64/32		3D0000h-3DFFFFh	1E8000h-1EFFFFh
62	64/32	Protection Group	3E0000h-3EFFFFh	1F0000h-1F7FFFh
63	64/32	1	3F0000h-3FFFFFh	1F8000h-1FFFFFh
64	64/32		400000h-40FFFFh	200000h-207FFFh
65	64/32		410000h-41FFFFh	208000h-20FFFFh
66	64/32	Protection Group	420000h-42FFFFh	210000h-217FFFh
67	64/32		430000h-43FFFFh	218000h-21FFFFh
68	64/32		440000h-44FFFFh	220000h-227FFFh
69	64/32		450000h-45FFFFh	228000h-22FFFFh
70	64/32	Protection Group	460000h-46FFFFh	230000h-237FFFh
71	64/32	1	470000h-47FFFFh	238000h-23FFFFh
72	64/32		480000h-48FFFFh	240000h-247FFFh
73	64/32	Boots sties Ossus	490000h-49FFFFh	248000h-24FFFFh
74	64/32	Protection Group	4A0000h-4AFFFFh	250000h-257FFFh
75	64/32	1	4B0000h-4BFFFFh	258000h-25FFFFh
76	64/32		4C0000h-4CFFFFh	260000h-267FFFh
77	64/32	Boots etian Comm	4D0000h-4DFFFFh	268000h-26FFFFh
78	64/32	Protection Group	4E0000h-4EFFFFh	270000h-277FFFh
79	64/32		4F0000h-4FFFFFh	278000h-27FFFFh
80	64/32		500000h-50FFFFh	280000h-287FFFh
81	64/32	Books of the Comme	510000h-51FFFFh	288000h-28FFFFh
82	64/32	Protection Group	520000h-52FFFFh	290000h-297FFFh
83	64/32		530000h-53FFFFh	298000h-29FFFFh
84	64/32		540000h-54FFFFh	2A0000h-2A7FFFh
85	64/32	Protection Crous	550000h-55FFFFh	2A8000h-2AFFFFh
86	64/32	Protection Group	560000h-56FFFFh	2B0000h-2B7FFFh
87	64/32] [570000h-57FFFFh	2B8000h-2BFFFFh
88	64/32		580000h-58FFFFh	2C0000h-2C7FFFh
89	64/32	Brotoction Group	590000h-59FFFFh	2C8000h-2CFFFFh
90	64/32	Protection Group	5A0000h-5AFFFFh	2D0000h-2D7FFFh
91	64/32		5B0000h-5BFFFFh	2D8000h-2DFFFFh



Block	KBytes/ KWords	Protection Block Group	(x8)	(x16)
92	64/32		5C0000h-5CFFFFh	2E0000h-2E7FFFh
93	64/32	Protection Group	5D0000h-5DFFFFh	2E8000h-2EFFFFh
94	64/32	Protection Group	5E0000h-5EFFFFh	2F0000h-2F7FFFh
95	64/32	1	5F0000h-5FFFFFh	2F8000h-2FFFFFh
96	64/32		600000h-60FFFFh	300000h-307FFFh
97	64/32	Drata etian Croun	610000h-61FFFFh	308000h-30FFFFh
98	64/32	Protection Group	620000h-62FFFFh	310000h-317FFFh
99	64/32		630000h-63FFFFh	318000h-31FFFFh
100	64/32		640000h-64FFFFh	320000h-327FFFh
101	64/32	Protection Group	650000h-65FFFFh	328000h-32FFFFh
102	64/32	- Protection Group	660000h-66FFFFh	330000h-337FFFh
103	64/32	1	670000h-67FFFFh	338000h-33FFFFh
104	64/32		680000h-68FFFFh	340000h-347FFFh
105	64/32	Protection Group	690000h-69FFFFh	348000h-34FFFFh
106	64/32	- Flotection Gloup	6A0000h-6AFFFFh	350000h-357FFFh
107	64/32	7	6B0000h-6BFFFFh	358000h-35FFFFh
108	64/32		6C0000h-6CFFFFh	360000h-367FFFh
109	64/32	Protection Group	6D0000h-6DFFFFh	368000h-36FFFFh
110	64/32	- Flotection Gloup	6E0000h-6EFFFFh	370000h-377FFFh
111	64/32		6F0000h-6FFFFFh	378000h-37FFFFh
112	64/32		700000h-70FFFFh	380000h-387FFFh
113	64/32	Drataction Croup	710000h–71FFFFh	388000h-38FFFFh
114	64/32	Protection Group	720000h-72FFFFh	390000h-397FFFh
115	64/32		730000h-73FFFFh	398000h-39FFFFh
116	64/32		740000h-74FFFFh	3A0000h-3A7FFFh
117	64/32	Protection Group	750000h-75FFFFh	3A8000h-3AFFFFh
118	64/32	Frotection Group	760000h-76FFFFh	3B0000h-3B7FFFh
119	64/32		770000h-77FFFFh	3B8000h-3BFFFFh
120	64/32		780000h-78FFFFh	3C0000h-3C7FFFh
121	64/32	Protection Group	790000h-79FFFFh	3C8000h-3CFFFFh
122	64/32	Frotection Group	7A0000h–7AFFFFh	3D0000h-3D7FFFh
123	64/32		7B0000h-7BFFFFh	3D8000h-3DFFFFh

Block	KBytes/ KWords	Protection Block Group	(x8)	(x16)
124	64/32		7C0000h-7CFFFFh	3E0000h-3E7FFFh
125	64/32		7D0000h-7DFFFFh	3E8000h-3EFFFFh
126	64/32		7E0000h-7EFFFFh	3F0000h-3F7FFFh
127	8/4		7F0000h-7F1FFFh	3F8000h-3F8FFFh
128	8/4		7F2000h-7F3FFFh	3F9000h-3F9FFFh
129	8/4	Protection Group	7F4000h-7F5FFFh	3FA000h-3FAFFFh
130	8/4		7F6000h-7F7FFFh	3FB000h-3FBFFFh
131	8/4		7F8000h-7F9FFFh	3FC000h-3FCFFFh
132	8/4		7FA000h-7FBFFFh	3FD000h-3FDFFFh
133	8/4		7FC000h-7FDFFFh	3FE000h-3FEFFFh
134	8/4		7FE000h-7FFFFFh	3FF000h-3FFFFFh

^{1.} Used as the Extended Block Addresses in Extended Block mode.

Table 21. Bottom Boot Block Addresses, M29W640FB

Name	Table 21.	KBytes/	Protection Block		
1	Block			(x8)	(x16)
2 8/4 3 8/4 4 8/4 4 8/4 5 8/4 6 8/4 7 8/4 8 64/32 9 64/32 10 64/32 11 64/32 12 64/32 13 64/32 14 64/32 15 64/32 16 64/32 17 8/4 18 64/32 19 64/32 11 64/32 12 64/32 13 64/32 14 64/32 15 64/32 16 64/32 17 64/32 18 64/32 19 70 10 64/32 11 64/32 12 64/32 13 64/32 14 64/32 15 <td>0</td> <td>8/4</td> <td></td> <td>000000h-001FFFh⁽¹⁾</td> <td>000000h-000FFFh⁽¹⁾</td>	0	8/4		000000h-001FFFh ⁽¹⁾	000000h-000FFFh ⁽¹⁾
3	1	8/4		002000h-003FFFh	001000h-001FFFh
4 8/4 Protection Group 008000h-009FFFh 004000h-004FFFh 5 8/4 008000h-009FFFh 005000h-005FFFh 6 8/4 006000h-00FFFFh 006000h-006FFFh 7 8/4 00E000h-00FFFFh 006000h-00FFFFh 8 64/32 010000h-01FFFFh 008000h-00FFFFh 9 64/32 030000h-03FFFFh 018000h-01FFFFh 10 64/32 040000h-04FFFFh 018000h-01FFFFh 11 64/32 040000h-04FFFFh 020000h-02FFFFh 12 64/32 040000h-04FFFFh 020000h-02FFFFh 13 64/32 050000h-05FFFFh 028000h-02FFFFh 14 64/32 060000h-05FFFFh 038000h-03FFFFh 15 64/32 080000h-08FFFFh 040000h-04FFFFh 16 64/32 080000h-08FFFFh 048000h-04FFFFh 17 64/32 080000h-08FFFFh 048000h-05FFFFh 18 64/32 08000h-08FFFFh 050000h-05FFFFh 19 64/32 06000h-08FFFFh 050000h-0	2	8/4		004000h-005FFFh	002000h-002FFFh
5 8/4 Protection Group 00A000h-00BFFFh 005000h-005FFFh 6 8/4 00C000h-00DFFFh 006000h-005FFFh 7 8/4 00E000h-00FFFFh 00F000h-00FFFFh 8 64/32 010000h-01FFFFh 007000h-00FFFFh 9 64/32 010000h-02FFFFh 010000h-01FFFFh 10 64/32 030000h-03FFFFh 018000h-01FFFFh 11 64/32 040000h-04FFFFh 020000h-02FFFFh 12 64/32 040000h-04FFFFh 020000h-02FFFFh 13 64/32 050000h-05FFFFh 028000h-02FFFFh 14 64/32 050000h-05FFFFh 028000h-02FFFFh 15 64/32 080000h-05FFFFh 038000h-03FFFFh 16 64/32 080000h-08FFFFh 040000h-04FFFFh 17 64/32 080000h-08FFFFh 048000h-04FFFFh 19 64/32 08000h-08FFFFh 050000h-05FFFFh 19 64/32 06000h-08FFFFh 050000h-05FFFFh 20 64/32 06000h-05FFFFh 060000h	3	8/4		006000h-007FFFh	003000h-003FFFh
6 8/4 7 8/4 8 64/32 9 64/32 10 64/32 10 64/32 11 64/32 12 64/32 13 64/32 14 64/32 15 64/32 16 64/32 17 64/32 18 64/32 19 64/32 10 64/32 11 64/32 12 64/32 13 64/32 14 64/32 15 64/32 16 64/32 17 64/32 18 64/32 19 64/32 20 64/32 21 64/32 22 64/32 23 64/32 24 64/32 25 64/32 26 64/32 27 64/32 <t< td=""><td>4</td><td>8/4</td><td></td><td>008000h-009FFFh</td><td>004000h-004FFFh</td></t<>	4	8/4		008000h-009FFFh	004000h-004FFFh
7 8/4 00E000h-00FFFh 007000h-007FFFh 8 64/32 010000h-01FFFh 008000h-00FFFFh 9 64/32 020000h-02FFFh 010000h-01FFFFh 10 64/32 030000h-03FFFFh 018000h-01FFFFh 11 64/32 040000h-04FFFFh 020000h-02FFFFh 12 64/32 050000h-05FFFFh 028000h-02FFFFh 13 64/32 060000h-05FFFFh 028000h-02FFFFh 14 64/32 060000h-05FFFFh 038000h-03FFFFh 15 64/32 080000h-05FFFFh 038000h-03FFFFh 16 64/32 080000h-05FFFFh 040000h-04FFFFh 17 64/32 080000h-05FFFFh 048000h-04FFFFh 19 64/32 060000h-05FFFFh 058000h-05FFFFh 19 64/32 060000h-05FFFFh 058000h-05FFFFh 20 64/32 060000h-05FFFFh 058000h-05FFFFh 21 64/32 060000h-05FFFFh 060000h-05FFFFh 22 64/32 060000h-05FFFFh 060000h-05FFFFh	5	8/4	Protection Group	00A000h-00BFFFh	005000h-005FFFh
8 64/32 010000h-01FFFFh 008000h-00FFFFh 9 64/32 020000h-02FFFFh 010000h-017FFFh 10 64/32 030000h-03FFFFh 018000h-01FFFFh 11 64/32 040000h-03FFFFh 020000h-02FFFFh 12 64/32 050000h-05FFFFh 028000h-02FFFFh 13 64/32 060000h-05FFFFh 028000h-02FFFFh 14 64/32 060000h-05FFFFh 038000h-03FFFFh 15 64/32 080000h-05FFFFh 038000h-03FFFFh 16 64/32 080000h-05FFFFh 040000h-04FFFFh 17 64/32 080000h-05FFFFh 040000h-04FFFFh 18 64/32 080000h-05FFFFh 050000h-05FFFFh 19 64/32 080000h-05FFFFh 050000h-05FFFFh 19 64/32 0C0000h-05FFFFh 050000h-05FFFFh 20 64/32 0C0000h-05FFFFh 060000h-05FFFFh 21 64/32 0C0000h-05FFFFh 060000h-05FFFFh 22 64/32 0Fo000h-05FFFFh 070000h-05FFFFh <td>6</td> <td>8/4</td> <td></td> <td>00C000h-00DFFFh</td> <td>006000h-006FFFh</td>	6	8/4		00C000h-00DFFFh	006000h-006FFFh
9 64/32 10 64/32 11 64/32 12 64/32 13 64/32 14 64/32 15 64/32 16 64/32 17 64/32 18 64/32 19 Protection Group Protection Group	7	8/4		00E000h-00FFFFh	007000h-007FFFh
10	8	64/32		010000h-01FFFFh	008000h-00FFFFh
11 64/32 Protection Group 040000h-04FFFh 020000h-027FFFh 12 64/32 050000h-05FFFFh 028000h-02FFFFh 13 64/32 060000h-05FFFFh 030000h-037FFFh 14 64/32 070000h-07FFFFh 038000h-03FFFFh 15 64/32 080000h-08FFFFh 040000h-047FFFh 16 64/32 090000h-09FFFFh 048000h-04FFFFh 17 64/32 090000h-08FFFFh 050000h-05FFFFh 18 64/32 080000h-08FFFFh 050000h-05FFFFh 19 64/32 0C0000h-08FFFFh 058000h-05FFFFh 20 64/32 0C0000h-0FFFFh 068000h-06FFFFh 21 64/32 0F0000h-0FFFFh 068000h-0FFFFh 22 64/32 0F0000h-0FFFFh 078000h-07FFFFh 23 64/32 0F0000h-0FFFFh 080000h-087FFFh 24 64/32 110000h-11FFFFh 080000h-087FFFh 25 64/32 120000h-12FFFFh 090000h-09FFFFh 26 64/32 130000h-13FFFFh <td< td=""><td>9</td><td>64/32</td><td></td><td>020000h-02FFFFh</td><td>010000h-017FFFh</td></td<>	9	64/32		020000h-02FFFFh	010000h-017FFFh
12 64/32 Protection Group 050000h-05FFFh 028000h-02FFFh 13 64/32 060000h-06FFFFh 030000h-037FFFh 14 64/32 070000h-07FFFFh 038000h-03FFFFh 15 64/32 080000h-08FFFFh 040000h-047FFFh 16 64/32 090000h-09FFFFh 048000h-04FFFFh 17 64/32 080000h-08FFFFh 050000h-05FFFFh 18 64/32 080000h-08FFFFh 050000h-05FFFFh 19 64/32 080000h-08FFFFh 058000h-05FFFFh 20 64/32 0C0000h-0FFFFFh 060000h-06FFFFh 21 64/32 0F0000h-0FFFFFh 068000h-06FFFFh 22 64/32 0F0000h-0FFFFFh 078000h-07FFFFh 23 64/32 100000h-10FFFFh 080000h-087FFFh 24 64/32 110000h-11FFFFh 080000h-087FFFh 25 64/32 120000h-12FFFFh 090000h-09FFFFh 26 64/32 130000h-13FFFFh 090000h-09FFFFh 27 64/32 140000h-14FFFFh	10	64/32		030000h-03FFFFh	018000h-01FFFFh
13 64/32 Protection Group 060000h-06FFFh 030000h-037FFFh 14 64/32 070000h-07FFFh 038000h-03FFFh 15 64/32 080000h-08FFFFh 040000h-047FFFh 16 64/32 090000h-09FFFFh 048000h-04FFFFh 04000h-04FFFFh 050000h-057FFFh 060000h-057FFFh 060000h-057FFFh 060000h-057FFFh 060000h-067FFFh 060000h-067FFFh 060000h-067FFFh 060000h-067FFFh 060000h-067FFFh 060000h-077FFFh 060000h-077FFFh 060000h-077FFFh 070000h-077FFFh 070000h-077FFFh 070000h-077FFFh 070000h-077FFFh 070000h-077FFFh 070000h-077FFFh 070000h-077FFFh 070000h-077FFFh 070000h-077FFFh 070000h-087FFFh 070000h-087FFFh 070000h-087FFFh 070000h-087FFFh 070000h-087FFFh 070000h-097FFFh	11	64/32		040000h-04FFFFh	020000h-027FFFh
13 64/32 060000h-06FFFFh 030000h-037FFFh 14 64/32 070000h-07FFFFh 038000h-03FFFFh 15 64/32 080000h-08FFFFh 040000h-047FFFh 16 64/32 090000h-09FFFFh 048000h-04FFFFh 17 64/32 090000h-08FFFFh 050000h-057FFFh 18 64/32 080000h-08FFFFh 058000h-05FFFFh 19 64/32 0C0000h-0FFFFh 058000h-05FFFFh 20 64/32 0C0000h-0FFFFh 068000h-06FFFFh 21 64/32 0F0000h-0FFFFh 070000h-0FFFFh 22 64/32 0F0000h-0FFFFh 078000h-07FFFh 23 64/32 10000h-10FFFFh 08000h-08FFFFh 24 64/32 110000h-11FFFFh 088000h-08FFFFh 25 64/32 120000h-12FFFFh 090000h-09FFFFh 26 64/32 130000h-13FFFFh 098000h-09FFFFh 27 64/32 140000h-14FFFFh 0A0000h-0AFFFFh 28 64/32 150000h-15FFFFh 0A8000h-0AFFFFh	12	64/32		050000h-05FFFFh	028000h-02FFFFh
15 64/32 080000h-08FFFh 040000h-047FFh 16 64/32 090000h-09FFFFh 048000h-04FFFh 17 64/32 0A0000h-0AFFFFh 050000h-057FFFh 18 64/32 0B0000h-0BFFFFh 058000h-05FFFFh 19 64/32 0C0000h-0CFFFFh 060000h-067FFFh 20 64/32 0D0000h-0DFFFFh 068000h-06FFFFh 21 64/32 0F0000h-0EFFFFh 070000h-077FFFh 22 64/32 0F0000h-0FFFFFh 078000h-07FFFFh 23 64/32 100000h-10FFFFh 080000h-087FFFh 24 64/32 110000h-11FFFFh 080000h-087FFFh 25 64/32 110000h-11FFFFh 090000h-097FFFh 26 64/32 130000h-13FFFFh 098000h-097FFFh 27 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 28 64/32 150000h-15FFFFh 0A8000h-0AFFFFh 29 64/32 150000h-16FFFFh 0B0000h-0B7FFFh	13	64/32	Protection Group	060000h-06FFFFh	030000h-037FFFh
16 64/32 Protection Group 090000h-09FFFh 048000h-04FFFh 17 64/32 0A0000h-0AFFFFh 050000h-057FFFh 18 64/32 0B0000h-0BFFFFh 058000h-05FFFFh 19 64/32 0C0000h-0CFFFFh 060000h-067FFFh 20 64/32 0D0000h-0DFFFFh 068000h-06FFFFh 21 64/32 0F0000h-0EFFFFh 078000h-077FFFh 22 64/32 0F0000h-0FFFFFh 078000h-07FFFFh 23 64/32 100000h-10FFFFh 080000h-087FFFh 24 64/32 110000h-11FFFFh 088000h-087FFFh 25 64/32 120000h-12FFFFh 090000h-097FFFh 26 64/32 130000h-13FFFFh 098000h-097FFFh 27 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 28 64/32 150000h-15FFFFh 0A8000h-0AFFFFh 29 64/32 150000h-16FFFFh 0B0000h-0B7FFFh	14	64/32		070000h-07FFFFh	038000h-03FFFFh
17 64/32 Protection Group 0A0000h-0AFFFFh 050000h-057FFFh 18 64/32 0B0000h-0BFFFFh 058000h-057FFFh 19 64/32 0C0000h-0CFFFFh 060000h-067FFFh 20 64/32 0D0000h-0DFFFFh 068000h-06FFFFh 21 64/32 0F0000h-0FFFFh 070000h-07FFFFh 22 64/32 0F0000h-0FFFFh 078000h-07FFFFh 23 64/32 100000h-10FFFFh 080000h-087FFFh 24 64/32 110000h-11FFFFh 088000h-08FFFFh 25 64/32 120000h-12FFFFh 090000h-09FFFFh 26 64/32 130000h-13FFFFh 098000h-09FFFFh 27 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 28 64/32 150000h-15FFFFh 0A8000h-0AFFFFh 29 64/32 160000h-16FFFFh 0B0000h-0B7FFFh	15	64/32		080000h-08FFFFh	040000h-047FFFh
17 64/32 0A0000h-0AFFFFh 050000h-057FFFh 18 64/32 0B0000h-0BFFFFh 058000h-05FFFFh 19 64/32 0C0000h-0CFFFFh 060000h-067FFFh 20 64/32 0D0000h-0DFFFFh 068000h-06FFFFh 21 64/32 0E0000h-0EFFFFh 070000h-07FFFFh 22 64/32 0F0000h-0FFFFFh 078000h-07FFFFh 23 64/32 100000h-10FFFFh 080000h-087FFFh 24 64/32 110000h-11FFFFh 088000h-087FFFh 25 64/32 120000h-12FFFFh 090000h-097FFFh 26 64/32 130000h-13FFFFh 098000h-097FFFh 27 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 28 64/32 150000h-15FFFFh 0A8000h-0AFFFFh 29 64/32 160000h-16FFFFh 0B0000h-0B7FFFh	16	64/32		090000h-09FFFFh	048000h-04FFFFh
19 64/32 Protection Group 0C0000h-0CFFFh 060000h-067FFh 20 64/32 0D0000h-0DFFFh 068000h-06FFFh 21 64/32 0E0000h-0EFFFh 070000h-07FFFh 22 64/32 0F0000h-0FFFFh 078000h-07FFFh 23 64/32 100000h-10FFFFh 080000h-087FFFh 24 64/32 110000h-11FFFFh 088000h-08FFFh 25 64/32 120000h-12FFFFh 090000h-097FFFh 26 64/32 130000h-13FFFFh 098000h-097FFFh 27 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 28 64/32 150000h-15FFFFh 0A8000h-0AFFFFh 29 64/32 160000h-16FFFFh 0B0000h-0B7FFFh	17	64/32	Protection Group	0A0000h-0AFFFFh	050000h-057FFFh
20 64/32 Protection Group 0D0000h-0DFFFh 068000h-06FFFh 21 64/32 0E0000h-0EFFFh 070000h-077FFFh 22 64/32 0F0000h-0FFFFh 078000h-07FFFh 23 64/32 100000h-10FFFFh 080000h-087FFFh 24 64/32 110000h-11FFFFh 088000h-08FFFh 25 64/32 120000h-12FFFFh 090000h-097FFFh 26 64/32 130000h-13FFFFh 098000h-09FFFFh 27 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 28 64/32 150000h-15FFFFh 0A8000h-0AFFFFh 29 64/32 160000h-16FFFFh 0B0000h-0B7FFFh	18	64/32		0B0000h-0BFFFFh	058000h-05FFFFh
21 64/32 Protection Group 0E0000h-0EFFFFh 070000h-077FFFh 22 64/32 0F0000h-0FFFFh 078000h-07FFFh 23 64/32 100000h-10FFFFh 080000h-087FFFh 24 64/32 110000h-11FFFFh 088000h-08FFFFh 25 64/32 120000h-12FFFFh 090000h-097FFFh 26 64/32 130000h-13FFFFh 098000h-09FFFFh 27 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 28 64/32 150000h-15FFFFh 0A8000h-0A7FFFh 29 64/32 160000h-16FFFFh 0B0000h-0B7FFFh	19	64/32		0C0000h-0CFFFFh	060000h-067FFh
21 64/32 0E0000h-0EFFFFh 070000h-077FFFh 22 64/32 0F0000h-0FFFFh 078000h-07FFFh 23 64/32 100000h-10FFFFh 080000h-087FFFh 24 64/32 110000h-11FFFFh 088000h-08FFFh 25 64/32 120000h-12FFFFh 090000h-097FFFh 26 64/32 130000h-13FFFFh 098000h-09FFFFh 27 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 28 64/32 150000h-15FFFFh 0A8000h-0A7FFFh 29 64/32 160000h-16FFFFh 0B0000h-0B7FFFh	20	64/32		0D0000h-0DFFFFh	068000h-06FFFFh
23 64/32 24 64/32 25 64/32 26 64/32 27 64/32 28 64/32 29 64/32 100000h-10FFFh 080000h-08FFFh 120000h-12FFFh 090000h-097FFFh 130000h-13FFFh 098000h-09FFFh 140000h-14FFFFh 0A0000h-0A7FFFh 0A8000h-0AFFFh 0A8000h-0AFFFFh 160000h-16FFFFh 0B0000h-0B7FFFh	21	64/32	Protection Group	0E0000h-0EFFFFh	070000h-077FFFh
24 64/32 Protection Group 110000h-11FFFh 088000h-08FFFh 25 64/32 120000h-12FFFh 090000h-097FFh 26 64/32 130000h-13FFFh 098000h-09FFFh 27 64/32 140000h-14FFFh 0A0000h-0A7FFh 28 64/32 150000h-15FFFh 0A8000h-0AFFFh 29 64/32 160000h-16FFFh 0B0000h-0B7FFFh	22	64/32		0F0000h-0FFFFh	078000h-07FFFh
25 64/32 Protection Group 120000h-12FFFh 090000h-097FFh 26 64/32 130000h-13FFFh 098000h-09FFFh 27 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 28 64/32 150000h-15FFFh 0A8000h-0AFFFFh 29 64/32 160000h-16FFFFh 0B0000h-0B7FFFh	23	64/32		100000h-10FFFFh	080000h-087FFFh
25 64/32 120000h-12FFFFh 090000h-097FFFh 26 64/32 130000h-13FFFh 098000h-09FFFh 27 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 28 64/32 150000h-15FFFFh 0A8000h-0AFFFFh 29 64/32 160000h-16FFFFh 0B0000h-0B7FFFh	24	64/32		110000h-11FFFFh	088000h-08FFFFh
27 64/32 28 64/32 29 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 150000h-15FFFFh 0A8000h-0AFFFFh 160000h-16FFFFh 0B0000h-0B7FFFh	25	64/32	Protection Group	120000h-12FFFFh	090000h-097FFFh
28 64/32 29 64/32 Protection Group 150000h-15FFFh 0A8000h-0AFFFh 160000h-16FFFh 0B0000h-0B7FFFh	26	64/32		130000h-13FFFFh	098000h-09FFFFh
29 64/32 Protection Group 160000h-16FFFFh 0B0000h-0B7FFFh	27	64/32		140000h-14FFFFh	0A0000h-0A7FFFh
29 64/32 160000h-16FFFh 0B0000h-0B7FFFh	28	64/32		150000h-15FFFFh	0A8000h-0AFFFFh
30 64/32 170000h-17FFFh 0B8000h–0BFFFFh	29	64/32	Protection Group	160000h-16FFFFh	0B0000h-0B7FFFh
	30	64/32		170000h-17FFFFh	0B8000h-0BFFFFh

Block	KBytes/ KWords	Protection Block Group	(x8)	(x16)
31	64/32		180000h-18FFFFh	0C0000h-0C7FFFh
32	64/32	Bratastian Cours	190000h-19FFFFh	0C8000h-0CFFFFh
33	64/32	Protection Group	1A0000h-1AFFFFh	0D0000h-0D7FFFh
34	64/32	1	1B0000h-1BFFFFh	0D8000h-0DFFFFh
35	64/32		1C0000h-1CFFFFh	0E0000h-0E7FFFh
36	64/32	Bratastian Cours	1D0000h-1DFFFFh	0E8000h-0EFFFFh
37	64/32	Protection Group	1E0000h-1EFFFFh	0F0000h-0F7FFFh
38	64/32		1F0000h-1FFFFFh	0F8000h-0FFFFFh
39	64/32		200000h-20FFFFh	100000h-107FFFh
40	64/32	Bratastian Cours	210000h-21FFFFh	108000h-10FFFFh
41	64/32	Protection Group	220000h-22FFFFh	110000h-117FFFh
42	64/32	1	230000h-23FFFFh	118000h-11FFFFh
43	64/32		240000h-24FFFFh	120000h-127FFFh
44	64/32	Protection Group	250000h-25FFFFh	128000h-12FFFFh
45	64/32	Protection Group	260000h-26FFFFh	130000h-137FFFh
46	64/32	1	270000h-27FFFFh	138000h-13FFFFh
47	64/32		280000h-28FFFFh	140000h-147FFFh
48	64/32	Brotaction Croup	290000h-29FFFFh	148000h-14FFFFh
49	64/32	Protection Group	2A0000h-2AFFFFh	150000h-157FFFh
50	64/32		2B0000h-2BFFFFh	158000h-15FFFFh
51	64/32		2C0000h-2CFFFFh	160000h-167FFFh
52	64/32	Bratastian Craws	2D0000h-2DFFFFh	168000h-16FFFFh
53	64/32	Protection Group	2E0000h-2EFFFFh	170000h-177FFFh
54	64/32	7	2F0000h-2FFFFFh	178000h-17FFFFh
55	64/32		300000h-30FFFFh	180000h-187FFFh
56	64/32	Brotoetics Crous	310000h-31FFFFh	188000h-18FFFFh
57	64/32	Protection Group	320000h-32FFFFh	190000h-197FFFh
58	64/32	7	330000h-33FFFFh	198000h-19FFFFh
59	64/32		340000h-34FFFFh	1A0000h-1A7FFFh
60	64/32	Protection Group	350000h-35FFFFh	1A8000h–1AFFFFh
61	64/32	- Frotection Group	360000h-36FFFFh	1B0000h-1B7FFFh
62	64/32	7	370000h-37FFFFh	1B8000h-1BFFFFh



Block	KBytes/ KWords	Protection Block Group	(x8)	(x16)
63	64/32		380000h-38FFFFh	1C0000h-1C7FFh
64	64/32		390000h-39FFFFh	1C8000h-1CFFFFh
65	64/32	Protection Group	3A0000h-3AFFFFh	1D0000h-1D7FFFh
66	64/32		3B0000h-3BFFFFh	1D8000h-1DFFFFh
67	64/32		3C0000h-3CFFFFh	1E0000h-1E7FFFh
68	64/32		3D0000h-3DFFFFh	1E8000h-1EFFFFh
69	64/32	Protection Group	3E0000h-3EFFFFh	1F0000h-1F7FFFh
70	64/32		3F0000h-3FFFFFh	1F8000h-1FFFFFh
71	64/32		400000h-40FFFFh	200000h-207FFFh
72	64/32		410000h-41FFFFh	208000h-20FFFFh
73	64/32	Protection Group	420000h-42FFFFh	210000h-217FFFh
74	64/32		430000h-43FFFFh	218000h-21FFFFh
75	64/32		440000h-44FFFFh	220000h-227FFFh
76	64/32		450000h-45FFFFh	228000h-22FFFFh
77	64/32	Protection Group	460000h-46FFFFh	230000h-237FFFh
78	64/32		470000h-47FFFFh	238000h-23FFFFh
79	64/32		480000h-48FFFFh	240000h-247FFFh
80	64/32	Drata etia a Craus	490000h-49FFFFh	248000h-24FFFFh
81	64/32	Protection Group	4A0000h-4AFFFFh	250000h-257FFFh
82	64/32	7	4B0000h-4BFFFFh	258000h-25FFFFh
83	64/32		4C0000h-4CFFFFh	260000h-267FFFh
84	64/32	Bustontian Comm	4D0000h-4DFFFFh	268000h-26FFFFh
85	64/32	Protection Group	4E0000h-4EFFFFh	270000h-277FFFh
86	64/32	7	4F0000h-4FFFFFh	278000h-27FFFFh
87	64/32		500000h-50FFFFh	280000h-287FFFh
88	64/32	Droto etics Crave	510000h-51FFFFh	288000h-28FFFFh
89	64/32	Protection Group	520000h-52FFFFh	290000h-297FFFh
90	64/32	7	530000h-53FFFFh	298000h-29FFFFh
91	64/32		540000h-54FFFFh	2A0000h-2A7FFFh
92	64/32	Drotostion Craws	550000h-55FFFFh	2A8000h-2AFFFFh
93	64/32	Protection Group	560000h-56FFFFh	2B0000h-2B7FFFh
94	64/32		570000h-57FFFFh	2B8000h–2BFFFFh

Block	KBytes/ KWords	Protection Block Group	(x8)	(x16)
95	64/32		580000h-58FFFFh	2C0000h-2C7FFFh
96	64/32]	590000h-59FFFFh	2C8000h-2CFFFFh
97	64/32	Protection Group	5A0000h-5AFFFFh	2D0000h-2D7FFFh
98	64/32	1	5B0000h-5BFFFFh	2D8000h-2DFFFFh
99	64/32		5C0000h-5CFFFFh	2E0000h-2E7FFFh
100	64/32		5D0000h-5DFFFFh	2E8000h-2EFFFFh
101	64/32	Protection Group	5E0000h-5EFFFFh	2F0000h-2F7FFFh
102	64/32		5F0000h-5FFFFFh	2F8000h-2FFFFFh
103	64/32		600000h-60FFFFh	300000h-307FFFh
104	64/32		610000h-61FFFFh	308000h-30FFFFh
105	64/32	Protection Group	620000h-62FFFFh	310000h-317FFFh
106	64/32	1	630000h-63FFFFh	318000h-31FFFFh
107	64/32		640000h-64FFFFh	320000h-327FFFh
108	64/32	Bratastian Cours	650000h-65FFFFh	328000h-32FFFFh
109	64/32	Protection Group	660000h-66FFFFh	330000h-337FFFh
110	64/32	1	670000h-67FFFh	338000h-33FFFFh
111	64/32		680000h-68FFFFh	340000h-347FFFh
112	64/32	Bratastian Craus	690000h-69FFFFh	348000h-34FFFFh
113	64/32	Protection Group	6A0000h-6AFFFFh	350000h-357FFFh
114	64/32	1	6B0000h-6BFFFFh	358000h-35FFFFh
115	64/32		6C0000h-6CFFFFh	360000h-367FFFh
116	64/32	Bratastian Craws	6D0000h-6DFFFFh	368000h-36FFFFh
117	64/32	Protection Group	6E0000h-6EFFFFh	370000h-377FFFh
118	64/32	7	6F0000h-6FFFFFh	378000h-37FFFFh
119	64/32		700000h-70FFFFh	380000h-387FFFh
120	64/32	Dratactic v. Crave	710000h-71FFFFh	388000h-38FFFFh
121	64/32	Protection Group	720000h-72FFFFh	390000h-397FFFh
122	64/32	7	730000h-73FFFFh	398000h-39FFFFh
123	64/32		740000h-74FFFFh	3A0000h-3A7FFFh
124	64/32	Dratactic v. Crave	750000h-75FFFFh	3A8000h-3AFFFFh
125	64/32	Protection Group	760000h-76FFFFh	3B0000h-3B7FFFh
126	64/32	7	770000h-77FFFFh	3B8000h-3BFFFFh



Block	KBytes/ KWords	Protection Block Group	(x8)	(x16)
127	64/32		780000h-78FFFFh	3C0000h-3C7FFFh
128	64/32	Protection Group	790000h-79FFFFh	3C8000h-3CFFFFh
129	64/32	Protection Group	7A0000h-7AFFFFh	3D0000h-3D7FFFh
130	64/32		7B0000h-7BFFFFh	3D8000h-3DFFFFh
131	64/32		7C0000h-7CFFFFh	3E0000h-3E7FFFh
132	64/32	Protection Group	7D0000h-7DFFFFh	3E8000h-3EFFFFh
133	64/32		7E0000h-7EFFFFh	3F0000h-3F7FFFh
134	64/32		7F0000h-7FFFFFh	3F8000h-3FFFFFh

^{1.} Used as the Extended Block Addresses in Extended Block mode.

Appendix B Common Flash Interface (CFI)

The Common Flash Interface is a JEDEC approved, standardized data structure that can be read from the Flash memory device. It allows a system software to query the device to determine various electrical and timing parameters, density information and functions supported by the memory. The system can interface easily with the device, enabling the software to upgrade itself when necessary.

When the CFI Query Command is issued the device enters CFI Query mode and the data structure is read from the memory. Tables 22, 23, 24, 25, 26, and 27, show the addresses used to retrieve the data.

The CFI data structure also contains a security area where a 64 bit unique security number is written (see *Table 27: Security Code Area*). This area can be accessed only in Read mode by the final user. It is impossible to change the security number after it has been written by ST.

Table 22. Query Structure Overview

Add	ress	Sub-section Name	Description	
x16	х8	Sub-section Name	Description	
10h	20h	CFI Query Identification String	Command set ID and algorithm data offset	
1Bh	36h	System Interface Information	Device timing & voltage information	
27h	4Eh	Device Geometry Definition	Flash device layout	
40h	80h	Primary Algorithm-specific Extended Query table	Additional information specific to the Primary Algorithm (optional)	
61h	C2h	Security Code Area	64 bit unique device number	

^{1.} Query data are always presented on the lowest order data outputs.

Table 23. CFI Query Identification String

y				
Address		Description	Value	
x8	Data	Description	l	
20h	0051h		"Q"	
22h	0052h	Query Unique ASCII String "QRY"	"R"	
24h	0059h		"Y"	
26h	0002h	Primary Algorithm Command Set and Control Interface ID code 16 bit	AMD	
28h	0000h	ID code defining a specific algorithm	Compatible	
2Ah	0040h	Address for Primary Algorithm extended Query table (see Table 26)	P = 40h	
2Ch	0000h	Address for Filmary Algorithm extended Query table (see Table 20)	P = 40N	
2Eh	0000h	Alternate Vendor Command Set and Control Interface ID Code	NA	
30h	0000h	second vendor - specified algorithm supported	IVA	
32h	0000h	Address for Alternate Algorithm extended Query table	NA	
34h	0000h	Address for Alternate Algorithm exterided Query table	INA	
	20h 22h 24h 26h 28h 2Ah 2Ch 2Eh 30h 32h	20h 0051h 22h 0052h 24h 0059h 26h 0002h 28h 0000h 2Ah 0040h 2Ch 0000h 30h 0000h 32h 0000h	Data Description Description	

^{1.} Query data are always presented on the lowest order data outputs (DQ7-DQ0) only. DQ8-DQ15 are '0'.

Table 24. CFI Query System Interface Information

Address		- Data	Description	Value
x16	х8	Data	Description	value
1Bh	36h	0027h	V _{CC} Logic Supply Minimum Program/Erase voltage bit 7 to 4BCD value in volts bit 3 to 0BCD value in 100 mV	2.7V
1Ch	38h	0036h	V _{CC} Logic Supply Maximum Program/Erase voltage bit 7 to 4BCD value in volts bit 3 to 0BCD value in 100 mV	3.6V
1Dh	3Ah	00B5h	V _{PP} [Programming] Supply Minimum Program/Erase voltage bit 7 to 4HEX value in volts bit 3 to 0BCD value in 100 mV	11.5V
1Eh	3Ch	00C5h	V _{PP} [Programming] Supply Maximum Program/Erase voltage bit 7 to 4HEX value in volts bit 3 to 0BCD value in 100 mV	12.5V
1Fh	3Eh	0004h	Typical timeout per single byte/word program = 2 ⁿ μs	16µs
20h	40h	0000h	Typical timeout for minimum size write buffer program = 2 ⁿ µs	NA
21h	42h	000Ah	Typical timeout per individual Block Erase = 2 ⁿ ms	1s
22h	44h	0000h	Typical timeout for full Chip Erase = 2 ⁿ ms	NA
23h	46h	0004h	Maximum timeout for byte/word program = 2 ⁿ times typical	256 µs
24h	48h	0000h	Maximum timeout for write buffer program = 2 ⁿ times typical	NA

Add	ress	Data Description		Value
x16	x8	Data	Description	value
25h	4Ah	0003h	Maximum timeout per individual Block Erase = 2 ⁿ times typical	8s
26h	4Ch	0000h	Maximum timeout for Chip Erase = 2 ⁿ times typical	NA

Table 25. Device Geometry Definition

Add	ress	Data	Description	Value
x16	x8	Data	Description	value
27h	4Eh	0017h	Device Size = 2 ⁿ in number of bytes	8 MByte
28h 29h	50h 52h	0002h 0000h	Flash Device Interface Code description	x8, x16 Async.
2Ah 2Bh	54h 56h	0004h 0000h	Maximum number of bytes in multi-byte program or page = 2 ⁿ	16 Bytes
2Ch	58h	0002h	Number of Erase Block Regions. It specifies the number of regions containing contiguous Erase Blocks of the same size.	2
2Dh 2Eh	5Ah 5Ch	0007h 0000h	Region 1 Information Number of Erase Blocks of identical size = 0007h+1	8
2Fh 30h	5Eh 60h	0020h 0000h	Region 1 Information Block size in Region 1 = 0020h * 256 byte	8Kbyte
31h 32h	62h 64h	007Eh 0000h	Region 2 Information Number of Erase Blocks of identical size= 007Eh+1	127
33h 34h	66h 68h	0000h 0001h	Region 2 Information Block size in Region 2 = 0100h * 256 byte	64Kbyte
35h 36h 37h	6Ah 6Ch 6Eh	0000h 0000h 0000h	Region 3 Information Number of Erase Blocks of identical size=007Fh+1 Region 3 Information	0
38h	70h	0000h	Block size in Region 3 = 0000h * 256 byte	0
39h 3Ah 3Bh	72h 74h 76h	0000h 0000h 0000h	Region 4 Information Number of Erase Blocks of Identical size=007Fh+1 Region 4 Information	0
3Ch	78h	0000h	Block size in Region 4 = 0000h * 256 byte	0

For Bottom Boot devices, Erase Block Region 1 is located from address 000000h to 007FFFh and Erase Block Region 2 from address 008000h to 3FFFFFh.
 For Top Boot devices, Erase Block Region 1 is located from address 000000h to 3F7FFFh and Erase Block Region 2 from address 3F8000h to 3FFFFFh.

577

Table 26. Primary Algorithm-Specific Extended Query Table

Address		D	B	
x16	x8	Data	Description	Value
40h	80h	0050h		"P"
41h	82h	0052h	Primary Algorithm extended Query table unique ASCII string "PRI"	"R"
42h	84h	0049h		" "
43h	86h	0031h	Major version number, ASCII	"1"
44h	88h	0033h	Minor version number, ASCII	"3"
45h	8Ah	0000h	Address Sensitive Unlock (bits 1 to 0) 00h = required, 01h = not required Silicon Revision Number (bits 7 to 2)	Yes
46h	8Ch	0002h	Erase Suspend 00h = not supported, 01h = Read only, 02 = Read and Write	2
47h	8Eh	0004h	Block Protection 00h = not supported, x = number of blocks per protection group	4
48h	90h	0001h	Temporary Block Unprotect 00h = not supported, 01h = supported	
49h	92h	0004h	Block Protect /Unprotect 04 = M29W640F	
4Ah	94h	0000h	Simultaneous Operations, 00h = not supported	No
4Bh	96h	0000h	Burst Mode: 00h = not supported, 01h = supported	No
4Ch	98h	0001h	Page Mode: 00h = not supported, 01h = 4 page word, 02h = 8 page word	Yes
4Dh	9Ah	00B5h	V _{PP} Supply Minimum Program/Erase voltage bit 7 to 4 HEX value in volts bit 3 to 0 BCD value in 100 mV	11.5V
4Eh	9Ch	00C5h	V _{PP} Supply Maximum Program/Erase voltage bit 7 to 4 HEX value in volts bit 3 to 0 BCD value in 100 mV	12.5V
4Fh	9Eh	0002h 0003h	Top/Bottom Boot Block Flag 02h = Bottom Boot device 03h = Top Boot device	-
50h	A0h	0001h	Program Suspend 00h = Not Supported 01h = Supported	Supported

577

Table 27. Security Code Area

Add	Address		Description	
x16	x8	Data	Bescription	
61h	C3h, C2h	XXXX		
62h	C5h, C4h	XXXX	64 hitunique device pumber	
63h	C7h, C6h	XXXX	64 bit: unique device number	
64h	C9h, C8h	XXXX		

Appendix C Extended Memory Block

The M29W640F has an extra block, the Extended Block, that can be accessed using a dedicated command.

This Extended Block is 128 Words in x16 mode and 256 Bytes in x8 mode. It is used as a security block to provide a permanent security identification number) or to store additional information.

The Extended Block is either Factory Locked or Customer Lockable, its status is indicated by bit DQ7. This bit is permanently set to either '1' or '0' at the factory and cannot be changed. When set to '1', it indicates that the device is factory locked and the Extended Block is protected. When set to '0', it indicates that the device is customer lockable and the Extended Block is unprotected. Bit DQ7 being permanently locked to either '1' or '0' is another security feature which ensures that a customer lockable device cannot be used instead of a factory locked one.

Bit DQ7 is the most significant bit in the Extended Block Verify Code and a specific procedure must be followed to read it. See "Extended Memory Block Verify Code" in *Table 3: Bus Operations, BYTE = VIL* and *Table 4: Bus Operations, BYTE = VIH*, for details of how to read bit DQ7.

The Extended Block can only be accessed when the device is in Extended Block mode. For details of how the Extended Block mode is entered and exited, refer to the Section 4.3.1: Enter Extended Block command and Section 4.3.2: Exit Extended Block command, and to Table 5 and Table 6: Commands, 8-bit mode, BYTE = VIL.

C.1 Factory Locked Extended Block

In devices where the Extended Block is factory locked, the Security Identification Number is written to the Extended Block address space (see *Table 28: Extended Block Address and Data*) in the factory. The DQ7 bit is set to '1' and the Extended Block cannot be unprotected.

C.2 Customer Lockable Extended Block

A device where the Extended Block is customer lockable is delivered with the DQ7 bit set to '0' and the Extended Block unprotected. It is up to the customer to program and protect the Extended Block but care must be taken because the protection of the Extended Block is not reversible.

There are two ways of protecting the Extended Block:

- Issue the Enter Extended Block command to place the device in Extended Block mode, then use the In-System Technique with RP either at V_{IH} or at V_{ID} (refer to Appendix D, Section D.2: In-System Technique and to the corresponding flowcharts, Figure 18 and Figure 19, for a detailed explanation of the technique).
- Issue the Enter Extended Block command to place the device in Extended Block mode, then use the Programmer Technique (refer to Appendix D, Section D.1: Programmer Technique and to the corresponding flowcharts, Figure 16 and Figure 17, for a detailed explanation of the technique).

Once the Extended Block is programmed and protected, the Exit Extended Block command must be issued to exit the Extended Block mode and return the device to Read mode.

Table 28. Extended Block Address and Data

Add	ress	Data		
х8	x16	Factory Locked	Customer Lockable	
000000h-00020Fh	000000h-00000Fh	Security Identification Number	Determined by Customer	
000021h-0000FFh	000010h-00007Fh	Unavailable	Determined by Customer	

Appendix D Block Protection

Block protection can be used to prevent any operation from modifying the data stored in the memory. The blocks are protected in groups, refer to *Appendix A: Block addresses*, *Table 20* and *Table 21* for details of the Protection Groups. Once protected, Program and Erase operations within the protected group fail to change the data.

There are three techniques that can be used to control Block Protection, these are the Programmer technique, the In-System technique and Temporary Unprotection. Temporary Unprotection is controlled by the Reset/Block Temporary Unprotection pin, \overline{RP} ; this is described in the Signal Descriptions section.

D.1 Programmer Technique

The Programmer technique uses high (V_{ID}) voltage levels on some of the bus pins. These cannot be achieved using a standard microprocessor bus, therefore the technique is recommended only for use in Programming Equipment.

To protect a group of blocks follow the flowchart in *Figure 16: Programmer Equipment Group Protect Flowchart*. To unprotect the whole chip it is necessary to protect all of the groups first, then all groups can be unprotected at the same time. To unprotect the chip follow *Figure 17: Programmer Equipment Chip Unprotect Flowchart. Table 29: Programmer Technique Bus Operations, BYTE = VIH or VIL, gives a summary of each operation.*

The timing on these flowcharts is critical. Care should be taken to ensure that, where a pause is specified, it is followed as closely as possible. Do not abort the procedure before reaching the end. Chip Unprotect can take several seconds and a user message should be provided to show that the operation is progressing.

D.2 In-System Technique

The In-System technique requires a high voltage level on the Reset/Blocks Temporary Unprotect pin, $\overline{\mathsf{RP}}^{(1)}$. This can be achieved without violating the maximum ratings of the components on the microprocessor bus, therefore this technique is suitable for use after the memory has been fitted to the system.

To protect a group of blocks follow the flowchart in *Figure 18: In-System Equipment Group Protect Flowchart*. To unprotect the whole chip it is necessary to protect all of the groups first, then all the groups can be unprotected at the same time. To unprotect the chip follow *Figure 19: In-System Equipment Chip Unprotect Flowchart*.

The timing on these flowcharts is critical. Care should be taken to ensure that, where a pause is specified, it is followed as closely as possible. Do not allow the microprocessor to service interrupts that will upset the timing and do not abort the procedure before reaching the end. Chip Unprotect can take several seconds and a user message should be provided to show that the operation is progressing.

Note: \overline{RP} can be either at V_{IH} or at V_{ID} when using the In-System Technique to protect the Extended Block.

Table 29. Programmer Technique Bus Operations, $\overline{\text{BYTE}} = \text{V}_{\text{IH}}$ or V_{IL}

Operation	Ē	G	w	Address Inputs A0-A21	Data Inputs/Outputs DQ15A-1, DQ14-DQ0
Block (Group) Protect ⁽¹⁾	V _{IL}	V _{ID}	V _{IL} Pulse	A9 = V _{ID} , A12-A21 = Block Address Others = X	Х
Chip Unprotect	V _{ID}	V _{ID}	V _{IL} Pulse	$A9 = V_{ID}, A12 = V_{IH}, A15 = V_{IH}$ Others = X	Х
Block (Group) Protection Verify	V _{IL}	V _{IL}	V _{IH}	A0, A2, A3 = V_{IL} , A1 = V_{IH} , A6 = V_{IL} , A9 = V_{ID} , A12-A21 = Block Address Others = X	Pass = XX01h Retry = XX00h
Block (Group) Unprotection Verify	V _{IL}	V _{IL}	V _{IH}	A0, A2, A3 = V_{IL} , A1 = V_{IH} , A6 = V_{IH} , A9 = V_{ID} , A12-A21 = Block Address Others = X	Retry = XX01h Pass = XX00h

^{1.} Block Protection Groups are shown in *Appendix A*, Tables 20 and 21.

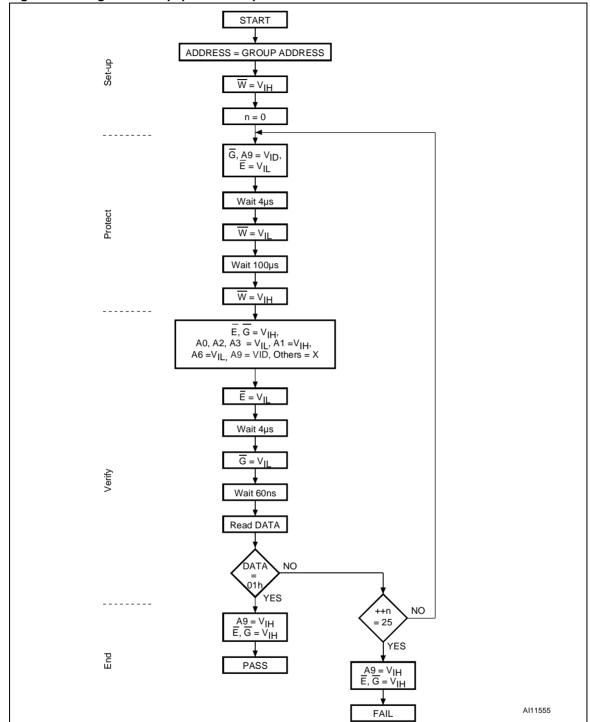


Figure 16. Programmer Equipment Group Protect Flowchart

47/

^{1.} Block Protection Groups are shown in *Appendix A*, Tables 20 and 21.

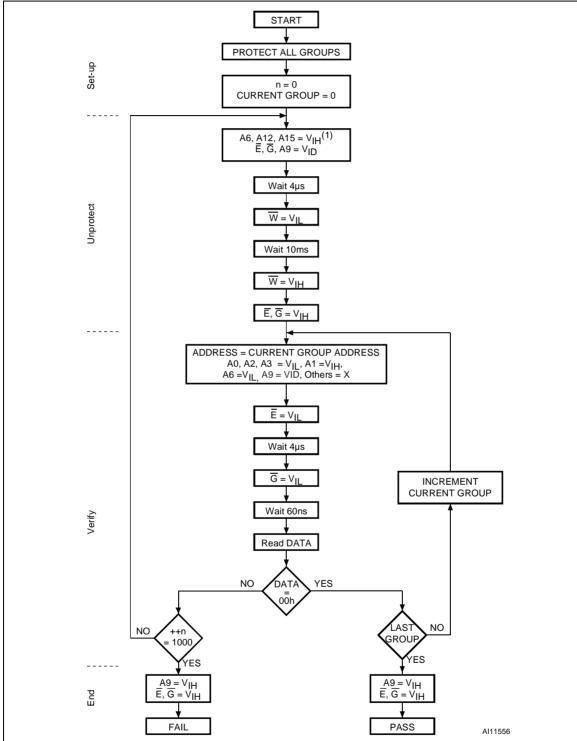


Figure 17. Programmer Equipment Chip Unprotect Flowchart

^{1.} Block Protection Groups are shown in Appendix A, Tables 20 and 21.

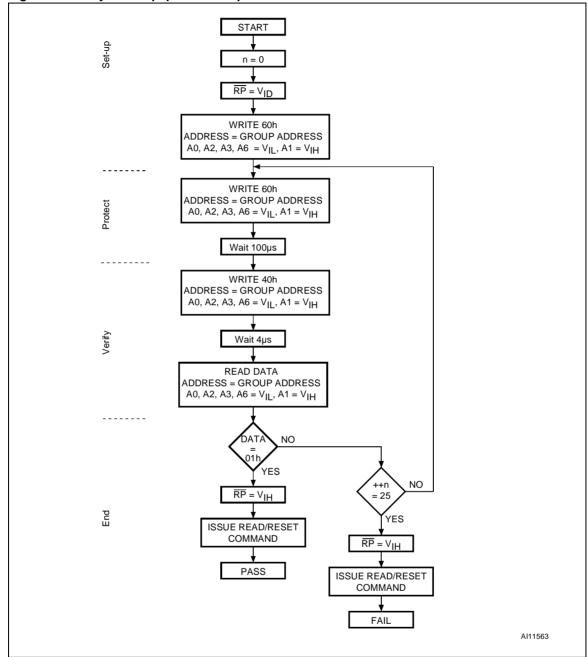
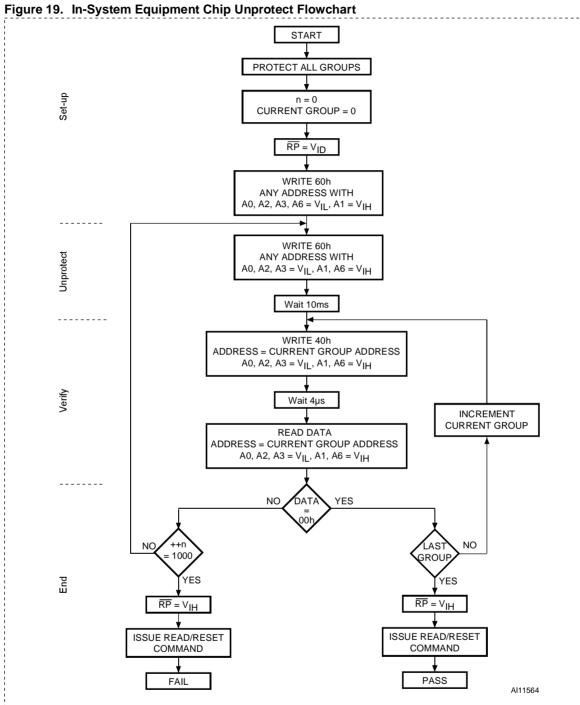


Figure 18. In-System Equipment Group Protect Flowchart

- 2. Block Protection Groups are shown in *Appendix A*, Tables 20 and 21.
- 3. \overline{RP} can be either at V_{IH} or at V_{ID} when using the In-System Technique to protect the Extended Block.



Block Protection Groups are shown in *Appendix A*, Tables 20 and 21.

10 Revision History

Table 30. Document Revision History

Date	Version	Revision Details		
01-Mar-2005	0.1	First Issue.		
17-May-2005	0.2	Asynchronous Page mode added. 70ns speed class added.		
07-Oct-2005	1.0	Device codes modified. TFBGA63 replaced by TFBGA48 6x8 package. ECOPACK text updated Page size changed to 4 Word. 90ns speed class removed. Quadruple Word/Octuple Byte Program command added. Table 3: Bus Operations, BYTE = VIL and Table 4: Bus Operations, BYTE = VIH: A0-A21 addresses for reading the Device Code, the Manufacturer Code, the Extended Memory Block Verify Code, and the Block Protection Status, have been updated. Appendix D: Block Protection: Table 29: Programmer Technique Bus Operations, BYTE = VIH or VIL: A0-A21 addresses updated for Block Protection/Unprotection Verify using the Programmer technique.		
02-Dec-2005	2	Datasheet status changed to "Full Datasheet". 60ns speed class added. Program Suspend and Resume added. Section 2.8: VPP/Write Protect (VPP/WP) and Section 4.2: Fast Program commands Section 4: Command Interface restructured. Table 28: Extended Block Address and Data updated.		
15-Dec-2005	3	Double Byte Program commands added in Section 4: Command Interface. Table 3: Bus Operations, BYTE = VIL and Table 4: Bus Operations, BYTE = VIH.: A6 changed from V_{IH} to V_{IL} for Read Block Protection Status operation.		



Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners

© 2005 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com_

